MCU Bootloader v2.7.0 Reference Manual

Document Number: MCUBOOTRM

Rev. 3, 11/2018



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Chapter 1 Introduction

1.1 Introduction

The MCU bootloader is a configurable flash programming utility that operates over a serial connection on MCU devices. It enables quick and easy programming of MCU devices through the entire product life cycle, including application development, final product manufacturing, and more. The bootloader is delivered in two ways. The MCU bootloader is provided as full source code that is highly configurable. The bootloader is also preprogrammed by NXP into ROM or flash on select devices. Host-side command line and GUI tools are available to communicate with the bootloader. Users can utilize host tools to upload and/or download application code via the bootloader.

1.2 Terminology

target

The device running the bootloader firmware (aka the ROM).

host

The device sending commands to the target for execution.

source

The initiator of a communications sequence. For example, the sender of a command or data packet.

destination

Receiver of a command or data packet.

incoming

Block diagram

From host to target.

outgoing

From target to host.

1.3 Block diagram

This block diagram describes the overall structure of the MCU bootloader.

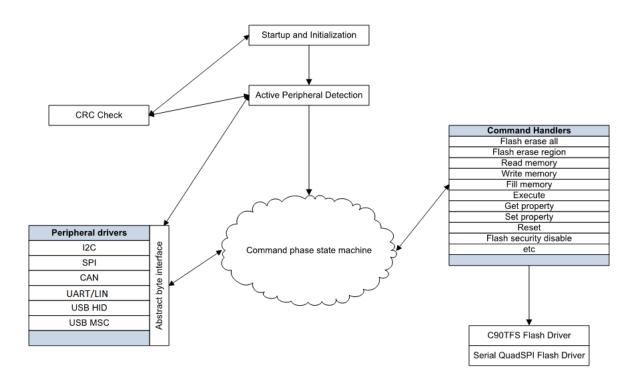


Figure 1-1. Block diagram

1.4 Features supported

Here are some of the features supported by the MCU bootloader:

- Supports UART, I2C, SPI, CAN, and USB peripheral interfaces.
- Automatic detection of the active peripheral.
- Ability to disable any peripheral.

- UART peripheral implements autobaud.
- Common packet-based protocol for all peripherals.
- Packet error detection and retransmit.
- Flash-resident configuration options.
- Fully supports flash security, including ability to mass erase or unlock security via the backdoor key.
- Protection of RAM used by the bootloader while it is running.
- Provides command to read properties of the device, such as flash and RAM size.
- Multiple options for executing the bootloader either at system start-up or under application control at runtime.
- Support for internal flash, serial QuadSPI, and other external memories.
- Support for encrypted image download.

1.5 Components supported

Components for the bootloader firmware:

- Startup code (clocking, pinmux, etc.)
- Command phase state machine
- Command handlers
 - GenericResponse
 - FlashEraseAll
 - FlashEraseRegion
 - ReadMemory
 - ReadMemoryResponse
 - WriteMemory
 - FillMemory
 - FlashSecurityDisable
 - GetProperty
 - GetPropertyResponse
 - Execute
 - Call
 - Reset
 - SetProperty
 - FlashEraseAllUnsecure
 - FlashProgramOnce
 - FlashReadOnce
 - FlashReadOnceResponse
 - FlashReadResource
 - FlashReadResourceResponse

Components supported

- ConfigureMemory
- ReliableUpdate
- SB file state machine
 - Encrypted image support (AES-128)
- Packet interface
 - Framing packetizer
 - Command/data packet processor
- Memory interface
 - Abstract interface
 - Flash Driver Interface
 - Low-level flash driver
 - QuadSPI interface
 - Low-level QuadSPI driver
 - On-the-fly QuadSPI decryption engine initialization
- Peripheral drivers
 - I2C slave
 - SPI slave
 - CAN
 - Auto-baud detector
 - UART
 - Auto-baud detector
 - USB device
 - USB controller driver
 - USB framework
 - USB HID class
 - USB Mass storage class
- CRC check engine
 - CRC algorithm

Chapter 2 Functional description

2.1 Introduction

The following subsections describe the MCU bootloader functionality.

2.2 Memory map

See MCU bootloader chapter of the reference manual of the particular System On Chip (SoC) for the ROM and RAM memory map used by the bootloader.

2.3 The MCU Bootloader Configuration Area (BCA)

The MCU bootloader reads data from the Bootloader Configuration Area (BCA) to configure various features of the bootloader. The BCA resides in flash memory at offset 0x3C0 from the beginning of the user application, and provides all of the parameters needed to configure the MCU bootloader operation. For uninitialized flash, the MCU bootloader uses a predefined default configuration. A host application can use the MCU bootloader to program the BCA for use during subsequent initializations of the bootloader.

NOTE

Flashloader does not support this feature.

Table 2-1. Configuration Fields for the MCU bootloader

Offset	Size (bytes)	Configuration Field	Description
0x00 - 0x03	4		Magic number to verify bootloader configuration is valid. Must be set to 'kcfg'.

Table continues on the next page...

The MCU Bootloader Configuration Area (BCA)

Table 2-1. Configuration Fields for the MCU bootloader (continued)

Offset	Size (bytes)	Configuration Field	Description
0x04 - 0x07	4	crcStartAddress	Start address for application image CRC check. To generate the CRC, see the CRC chapter.
0x08 - 0x0B	4	crcByteCount	Byte count for application image CRC check.
0x0C - 0x0F	4	crcExpectedValue	Expected CRC value for application CRC check.
0x10	1	enabledPeripherals	Bitfield of peripherals to enable.
			bit 0 UART
			bit 1 I2C
			bit 2 SPI bit 3 CAN
			bit 4 USB-HID
			bit 7 USB MSC
0x11	1	i2cSlaveAddress	If not 0xFF, used as the 7-bit I2C slave address.
0x12 - 0x13	2	peripheralDetectionTimeout	If not 0xFF, used as the timeout in milliseconds for active peripheral detection.
0x14 - 0x15	2	usbVid	Sets the USB Vendor ID reported by the device during enumeration.
0x16- 0x17	2	usbPid	Sets the USB Product ID reported by the device during enumeration.
0x18 - 0x1B	4	usbStringsPointer	Sets the USB Strings reported by the device during enumeration.
0x1C	1	clockFlags	See clockFlags Configuration Field.
0x1D	1	clockDivider	Inverted value of the divider used for core and bus clocks when in high-speed mode.
0x1E	1	bootFlags	One's complement of direct boot flag. 0xFE represents direct boot.
0x1F	1	pad0	Reserved, set to 0xFF.
0x20 - 0x23	4	mmcauConfigPointer	Reserved, holds a pointer value to the MMCAU configuration.
0x24 - 0x27	4	keyBlobPointer	Reserved, holds a value to the key blob array used to configure OTFAD.
0x28	1	pad1	Reserved.
0x29	1	canConfig1	ClkSel[1], PropSeg[3], SpeedIndex[4]
0x2A - 0x2B	2	canConfig2	Pdiv[8], Pseg[3], Pseg2[3], rjw[2]
0x2C - 0x2D	2	canTxld	txld
0x2E - 0x2F	2	canRxId	rxld
0x30 - 0x33	4	qspiConfigBlockPointer	QuadSPI configuration block pointer

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The first configuration field 'tag' is a tag value or magic number. The tag value must be set to 'kcfg' for the bootloader configuration data to be recognized as valid. If tag-field verification fails, the MCU bootloader acts as if the configuration data is not present. The tag value is treated as a character string, so bytes 0-3 must be set as shown in the table.

 Offset
 tag Byte Value

 0
 'k' (0x6B)

 1
 'c' (0x63)

 2
 'f' (0x66)

 3
 'g' (0x67)

Table 2-2. tag Configuration Field

The flags in the clockFlags configuration field are enabled if the corresponding bit is cleared (0).

Bit	Flag	Description	
0 HighSpeed		Enable high-speed mode (i.e., 48 MHz).	
1 - 7	-	Reserved.	

Table 2-3. clockFlags Configuration Field

2.4 Start-up process

It is important to note that the startup process for bootloader in ROM, RAM (flashloader), and flash (flash-resident) are slightly different. See the chip-specific reference manual for understanding the startup process for the ROM bootloader and flashloader. This section focuses on the flash-resident bootloader startup only.

There are two ways to get into the flash-resident bootloader.

- 1. If the vector table at the start of internal flash holds a valid PC and SP, the hardware boots into the bootloader.
- 2. A user application running on flash or RAM calls into the MCU bootloader entry point address in flash to start the MCU bootloader execution.

After the MCU bootloader has started, the following procedure starts the bootloader operations:

- 1. Initializes the bootloader's .data and .bss sections.
- 2. Reads the bootloader configuration data from flash at offset 0x3C0. The configuration data is only used if the tag field is set to the expected 'kcfg' value. If the

Start-up process

tag is incorrect, the configuration values are set to default, as if the data was all 0xFF bytes.

- 3. Clocks are configured.
- 4. Enabled peripherals are initialized.
- 5. The the bootloader waits for communication to begin on a peripheral.
 - If detection times out, the bootloader jumps to the user application in flash if the valid PC and SP addresses are specified in the application vector table.
 - If communication is detected, all inactive peripherals are shut down, and the command phase is entered.

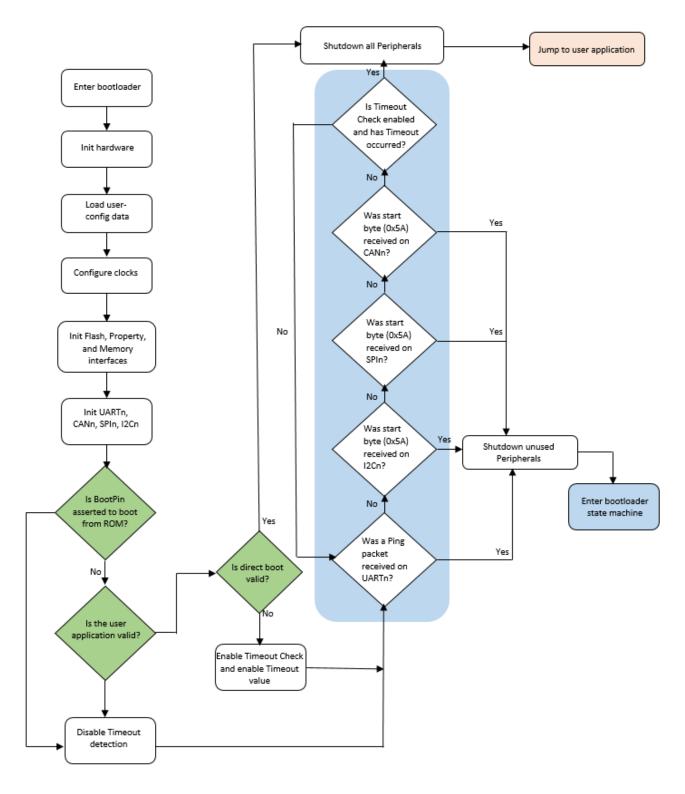


Figure 2-1. MCU bootloader start-up flowchart

2.5 Clock configuration

The clock configuration used by the bootloader depends on the clock settings in the bootloader configuration area and the requirements of the enabled peripherals. The bootloader starts by using the default clock configuration of the part out of reset.

- Alternate clock configurations are supported by setting fields in the bootloader configuration data.
- If the HighSpeed flag of the clockFlags configuration value is cleared, the core and bus clock frequencies are determined by the clockDivider configuration value.
- The core clock divider is set directly from the inverted value of clockDivider, unless a USB peripheral is enabled. If a USB peripheral is enabled and clockDivider is greater than 2, clockDivider is reduced to 2 in order to keep the CPU clock above 20 MHz.
- The bus clock divider is set to 1, unless the resulting bus clock frequency is greater than the maximum supported value. In this instance, the bus clock divider is increased until the bus clock frequency is at or below the maximum.
- The flash clock divider is set to 1, unless the resulting flash clock frequency is greater than the maximum supported value. In this instance, the flash clock divider is increased until the flash clock frequency is at or below the maximum.
- If flex bus is available, the flex bus clock divider is set to 1, unless the resulting flex bus clock frequency is greater than the maximum supported value. In this instance, the flex bus clock divider is increased until the flex bus clock frequency is at or below the maximum.
- If a USB peripheral is enabled, the IRC48Mhz clock is selected as the USB peripheral clock and the clock recovery feature is enabled.
- Note that the maximum baud rate of serial peripherals is related to the core and bus clock frequencies.
- Note that the bootloader code does not always configure the device core clock to run at 48 MHz. For devices with no USB peripheral and when HighSpeed flag is not enabled in the BCA, the core clock is configured to run at default clock rate (i.e., 20.9 MHz). This is also true for devices with USB but HighSpeed flag is not enabled in the BCA.

2.6 Bootloader entry point

The MCU bootloader provides a function (runBootloader) that a user application can call, to run the bootloader.

NOTE

Flashloader does not support this feature.

To get the address of the entry point, the user application reads the word containing the pointer to the bootloader API tree at offset 0x1C of the bootloader's vector table. The vector table is placed at the base of the bootloader's address range.

The bootloader API tree is a structure that contains pointers to other structures, which have the function and data addresses for the bootloader. The bootloader entry point is always the first word of the API tree.

The prototype of the entry point is:

```
void run_bootloader(void * arg);
```

The arg parameter is currently unused, and intended for future expansion. For example, passing options to the bootloader. To ensure future compatibility, a value of NULL should be passed for arg.

Example code to get the entry pointer address from the ROM and start the bootloader:

```
// Variables
uint32_t runBootloaderAddress;
void (*runBootloader) (void * arg);

// Read the function address from the ROM API tree.
runBootloaderAddress = **(uint32_t **)(0x1c00001c);
runBootloader = (void (*)(void * arg))runBootloaderAddress;

// Start the bootloader.
runBootloader(NULL);
```

NOTE

The user application must be executing at Supervisor (Privileged) level when calling the bootloader entry point.

2.7 Application integrity check

The application integrity check is an important step in the boot process. The MCU bootloader provides an option, and when enabled, does not allow the application code to execute on the device unless it passes the integrity check.

MCU bootloader uses CRC-32 as its integrity checker algorithm. To properly configure this feature, the following fields in the BCA must be set to valid values:

• Set crcStartAddress to the start address that should be used for the CRC check. This is generally the start address of the application image, where it resides in the flash or QuadSPI memory.

Application integrity check

- Set crcByteCount to the number of bytes to run the CRC check from the start address. This is generally the length of the application image in bytes.
- Set crcExpectedValue to the checksum. This is the pre-calculated value of the checksum stored in the BCA for the bootloader to compare with the resultant CRC calculation. If the resultant value matches with the crcExpectedValue, then the application image passes the CRC check.

NOTE

See Section 2.3, "The MCU Bootloader Configuration Area (BCA)", in the MCU Bootloader v2.7.0 Reference Manual (document MCUBOOTRM) for details about the BCA.

2.7.1 MCU bootloader flow with integrity checker

The following steps describe the flow of execution of the MCU bootloader when integrity check is enabled in the BCA.

2.7.1.1 Bootloader initialization

- Load BCA data from flash at offset, corresponding to the application image start address + 0x3C0.
- Initialize the CRC check status. If BCA is invalid (the tag is not set to expected 'kcfg' value), or the CRC parameters in valid BCA are not set, then the CRC check status is set to kStatus_AppCrcCheckInvalid, meaning the integrity check is not enabled for the device. Otherwise, the CRC check status is set to kStatus_AppCrcCheckInactive, meaning the integrity check is due for the device.
- If a boot pin is not asserted and application address is a valid address (the address is not null, the address resides in a valid executable memory range, and the flash is not blank), then the bootloader begins the CRC check function. Otherwise, the CRC check function is bypassed.
- The CRC check function. The bootloader checks the CRC check status initialized in the previous steps, and if it is not kStatus_AppCrcCheckInvalid (integrity check is enabled for the device), then the bootloader verifies the application resides in internal flash or external QSPI flash.
 - a. If the application address range is invalid, then the bootloader sets the status to kStatus_AppCrcCheckOutOfRange.

b. If the application address range is valid, then the CRC check process begins. If the CRC check passes, then the bootloader sets the status to kStatus_AppCrcCheckPassed. Otherwise, the status is set to kStatus_AppCrcCheckFailed.

2.7.1.2 Staying in or leaving bootloader

• If no active peripheral is found before the end of the detection, the timeout period expires, and the current CRC check status is either set to kStatus_AppCrcCheckInvalid (integrity check is not enabled for the device), or kStatus_AppCrcCheckPassed. Then, the bootloader jumps to the application image. Otherwise, the bootloader enters the active state and wait for commands from the host.

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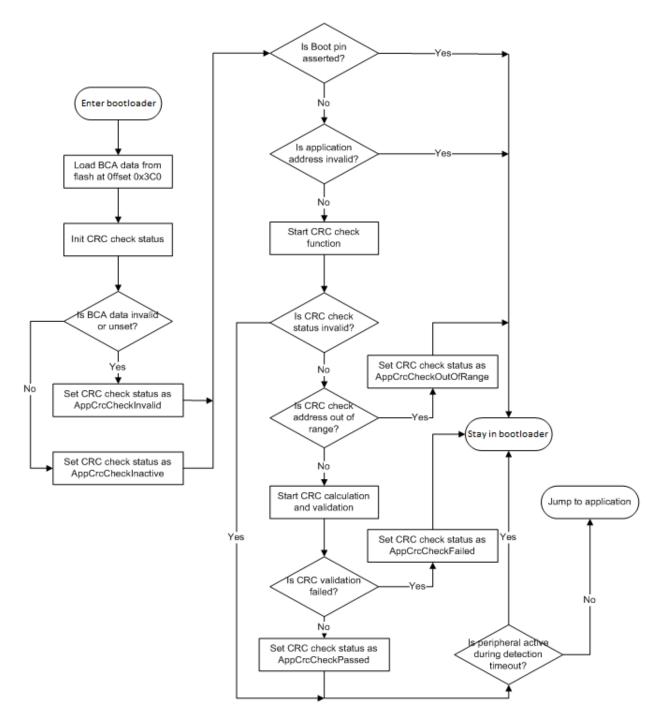


Figure 2-2. Application integrity check flow

The following table provides the CRC algorithm which is used for the application integrity check. The CRC algorithm is the MPEG2 variant of CRC-32.

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The characteristics of the MPEG2 variant are:

Table 2-4. MPEG2 variant characteristics

Width	32
Polynomial	0x04C11BD7
Init Value	0xFFFFFFF
Reflect In	FALSE
Reflect Out	FALSE
XOR Out	0x0000000

The bootloader computes the CRC over each byte in the application range specified in the BCA, excluding the crcExpectedValue field in the BCA. In addition, MCU bootloader automatically pads the extra byte(s) with zero(s) to finalize CRC calculation if the length of the image is not 4-bytes aligned.

The following procedure shows the steps in CRC calculation.

- 1. CRC initialization
 - Set the initial CRC as 0xFFFFFFF, which clears the CRC byte count to 0.
- 2. CRC calculation
 - Check if the crcExpectedValue field in BCA resides in the address range specified for CRC calculation.
 - If the crcExpectedValue does not reside in the address range, then compute CRC over every byte value in the address range.
 - If the crcExpectedValue does reside in the address range, then split the address range into two parts, splitting at the address of crcExpectedValue field in BCA excluding crcExpectedValue. Then, compute the CRC on the two parts.
 - Adjust the CRC byte count according to the actual bytes computed.
- 3. CRC finalization
 - Check if the CRC byte count is not 4-bytes aligned. If it is 4-bytes aligned, then pad it with necessary zeroes to finalize the CRC. Otherwise, return the current computed CRC.

NOTE

MCU bootloader assumes that crcExpectedValue field (4 bytes) resides in the CRC address range completely if it borders on the CRC address range.

Application integrity check

Chapter 3 MCU bootloader protocol

3.1 Introduction

This section explains the general protocol for the packet transfers between the host and the MCU bootloader. The description includes the transfer of packets for different transactions, such as commands with no data phase, and commands with an incoming or outgoing data phase. The next section describes the various packet types used in a transaction.

Each command sent from the host is replied to with a response command.

Commands may include an optional data phase.

- If the data phase is incoming (from the host to MCU bootloader), it is part of the original command.
- If the data phase is outgoing (from MCU bootloader to host), it is part of the response command.

3.2 Command with no data phase

NOTE

In these diagrams, the Ack sent in response to a Command or Data packet can arrive at any time before, during, or after the Command/Data packet has processed.

Command with no data phase

The protocol for a command with no data phase contains:

- Command packet (from host)
- Generic response command packet (to host)

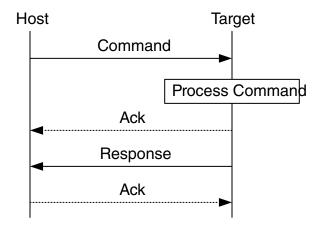


Figure 3-1. Command with no data phase

3.3 Command with incoming data phase

The protocol for a command with incoming data phase contains:

- Command packet (from host)(kCommandFlag_HasDataPhase set)
- Generic response command packet (to host)
- Incoming data packets (from host)
- Generic response command packet (to host)

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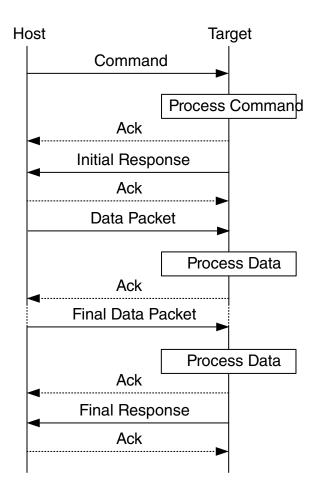


Figure 3-2. Command with incoming data phase

Notes

- The host may not send any further packets while it is waiting for the response to a command.
- The data phase is aborted if, prior to the start of the data phase, the Generic Response packet does not have a status of kStatus_Success.
- Data phases may be aborted by the receiving side by sending the final Generic Response early with a status of kStatus_AbortDataPhase. The host may abort the data phase early by sending a zero-length data packet.
- The final Generic Response packet sent after the data phase includes the status for the entire operation.

3.4 Command with outgoing data phase

The protocol for a command with an outgoing data phase contains:

- Command packet (from host)
- ReadMemory Response command packet (to host)(kCommandFlag_HasDataPhase set)
- Outgoing data packets (to host)
- Generic response command packet (to host)

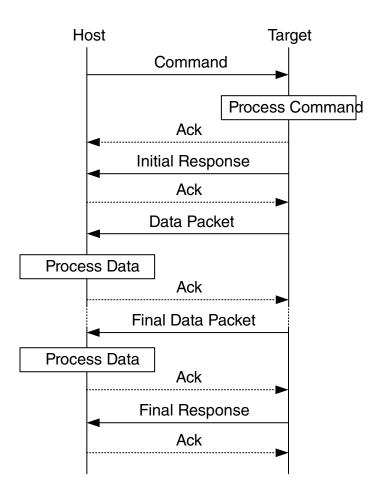


Figure 3-3. Command with outgoing data phase

Note

- The data phase is considered part of the response command for the outgoing data phase sequence.
- The host may not send any further packets while the host is waiting for the response to a command.
- The data phase is aborted if, prior to the start of the data phase, the ReadMemory Response command packet does not contain the kCommandFlag_HasDataPhase flag.
- Data phases may be aborted by the host sending the final Generic Response early with a status of kStatus_AbortDataPhase. The sending side may abort the data phase early by sending a zero-length data packet.
- The final Generic Response packet sent after the data phase includes the status for the entire operation.

Command with outgoing data phase

Chapter 4 Bootloader packet types

4.1 Introduction

The MCU bootloader device works in the slave mode. All data communication is initiated by a host, which is either a PC or an embedded host. The MCU bootloader device is the target that receives a command or a data packet. All data communication between the host and the target is packetized.

NOTE

The term "target" refers to the "MCU bootloader device".

There are six types of packets used:

- Ping packet
- Ping Response packet
- Framing packet
- Command packet
- Data packet
- Response packet

All fields in the packets are in the little-endian byte order.

4.2 Ping packet

The Ping packet is the first packet sent from the host to the target to establish a connection on a selected peripheral to run the autobaud. The Ping packet can be sent from the host to the target anytime that the target is expecting a command packet. If the selected peripheral is UART, the ping packet must be sent before any other communications. For other serial peripherals it is optional, but it is recommended to determine the serial protocol version.

In response to the Ping packet, the target sends the Ping Response packet, discussed further on in the document.

Table 4-1. Ping packet format

Byte #	Value	Name
0	0x5A	start byte
1	0xA6	ping

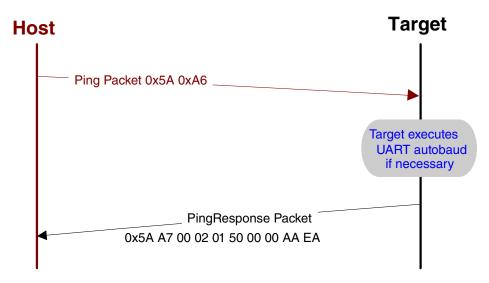


Figure 4-1. Ping packet protocol sequence

4.3 Ping Response packet

The target sends the Ping Response packet back to the host after receiving the Ping packet. If the communication is over a UART peripheral, the target uses the incoming Ping packet to determine the baud rate before replying with the Ping Response packet. When the Ping Response packet is received by the host, the connection is established and the host starts sending commands to the target.

Table 4-2. Ping Response packet format

Byte #	Value	Parameter
0	0x5A	start byte
1	0xA7	Ping response code
2		Protocol bugfix
3		Protocol minor
4		Protocol major
5		Protocol name = 'P' (0x50)
6		Options low
7		Options high

Table continues on the next page...

Table 4-2. Ping Response packet format (continued)

Byte #	Value	Parameter
8		CRC16 low
9		CRC16 high

The Ping Response packet can be sent from the host to the target anytime the target expects a command packet. For the UART peripheral to run the autobaud, it must be sent by the host when a connection is first established. It is optional for the other serial peripherals, but it is recommended to determine the serial protocol version. The version number is in the same format as the bootloader version number returned by the GetProperty command.

4.4 Framing packet

The framing packet is used for the flow control and error detection for the communications links that do not have such features built in. The framing packet structure sits between the link layer and the command layer. It wraps the command and data packets as well.

Every framing packet containing data sent in one direction results in a synchronizing response framing packet in the opposite direction.

The framing packet described in this section is used for serial peripherals including the UART, I2C, and SPI. The USB HID peripheral does not use the framing packets. Instead, the packetization inherent in the USB protocol itself is used.

Table 4-3. Framing Packet Format

Byte #	Value	Parameter	
0	0x5A	start byte	
1		packetType	
2		length_low	Length is a 16-bit field that specifies the entire
3		length_high	command or data packet size in bytes.
4		crc16_low	This is a 16-bit field. The CRC16 value covers the
5		crc16_high	entire framing packet, including the start byte and command or data packets, but does not include the CRC bytes. See the CRC16 algorithm after this table
6n		Command or Data packet payload	

CRC16 algorithm

A special framing packet that contains only a start byte and a packet type is used for synchronization between the host and the target.

Table 4-4. Special Framing Packet Format

Byte #	Value	Parameter
0	0x5A	start byte
1	0xAn	packetType

The Packet Type field specifies the type of the packet from one of these defined types:

Table 4-5. packetType Field

packetType	Name	Description
0xA1	kFramingPacketType_Ack	The previous packet was received successfully; the sending of more packets is allowed.
0xA2	kFramingPacketType_Nak	The previous packet was corrupt and must be re-sent.
0xA3	kFramingPacketType_AckAbort	The data phase is being aborted.
0xA4	kFramingPacketType_Command	The framing packet contains a command packet payload.
0xA5	kFramingPacketType_Data	The framing packet contains a data packet payload.
0xA6	kFramingPacketType_Ping	Sent to verify that the other side is alive. Also used for the UART autobaud.
0xA7	kFramingPacketType_PingResponse	A response to Ping; contains the framing protocol version number and options.

4.5 CRC16 algorithm

This section provides the CRC16 algorithm.

The CRC is computed over each byte in the framing packet header, excluding the crc16 field itself, plus all payload bytes. The CRC algorithm is the XMODEM variant of CRC-16.

The characteristics of the XMODEM variant are:

Table 4-6. XMODEM charactertistics

width	16
polynomial	0x1021
init value	0x0000
reflect in	false
reflect out	false
xor out	0x0000
check result	0x31c3

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The check result is computed by running the ASCII character sequence "123456789" through the algorithm.

4.6 Command packet

The command packet carries a 32-bit command header and a list of 32-bit parameters.

Command packet format (32 bytes) Command header (4 bytes) 28 bytes for Parameters (Max 7 parameters) Param3 Param5 Tag Flags Rsvd Param Param1 Param2 Param4 Param6 Param7 Count (32-bit) (32-bit) (32-bit) (32-bit) (32-bit) (32-bit) (32-bit) byte 0 byte 1 byte 2 byte 3

Table 4-7. Command packet format

Table 4-8. Command Header format

Byte #	Command header field	
0	Command or Response tag	The command header is 4 bytes long, with
1	Flags	these fields.
2	Reserved. Should be 0x00.	
3	ParameterCount	

The header is followed by 32-bit parameters up to the value of the ParameterCount field specified in the header. Because a command packet is 32 bytes long, only seven parameters fit into the command packet.

Command packet

The command packets are also used by the target to send responses back to the host. The command packets and data packets are embedded into the framing packets for all of the transfers.

Table 4-9. Command Tags

Command Tags	Name	
0x01	FlashEraseAll	The command tag specifies one of the
0x02	FlashEraseRegion	commands supported by the MCU bootloader. The valid command tags for the MCU
0x03	ReadMemory	bootloader are listed here.
0x04	WriteMemory	
0x05	FillMemory	
0x06	FlashSecurityDisable	
0x07	GetProperty	
0x08	Reserved	
0x09	Execute	
0x10	FlashReadResource	
0x11	Reserved	
0x0A	Call	
0x0B	Reset	
0x0C	SetProperty	
0x0D	FlashEraseAllUnsecure	
0x0E	FlashProgramOnce	
0x0F	FlashReadOnce	
0x10	FlashReadResource	
0x11	ConfigureMemory	
0x12	ReliableUpdate	

Table 4-10. Response Tags

Response Tag	Name	
0xA0	GenericResponse	The response tag specifies one of the responses
0xA7	GetPropertyResponse (used for sending responses to GetProperty command only)	the MCU bootloader (target) returns to the host. The valid response tags are listed here.
0xA3	ReadMemoryResponse (used for sending responses to ReadMemory command only)	
0xAF	FlashReadOnceResponse (used for sending responses to FlashReadOnce command only)	
0xB0	FlashReadResourceResponse (used for sending responses to FlashReadResource command only)	

Flags: Each command packet contains a flag byte. Only bit 0 of the flag byte is used. If bit 0 of the flag byte is set to 1, then the data packets follow in the command sequence. The number of bytes that are transferred in the data phase is determined by a command-specific parameter in the parameters array.

ParameterCount: The number of parameters included in the command packet.

Parameters: The parameters are word-length (32 bits). With the default maximum packet size of 32 bytes, a command packet can contain up to seven parameters.

4.7 Response packet

The responses are carried using the same command packet format wrapped with the framing packet data. The types of responses include:

- GenericResponse
- GetPropertyResponse
- ReadMemoryResponse
- FlashReadOnceResponse
- FlashReadResourceResponse

GenericResponse: After the MCU bootloader has processed a command, the bootloader sends a generic response with the status and command tag information to the host. The generic response is the last packet in the command protocol sequence. The generic response packet contains the framing packet data and the command packet data (with generic response tag = 0xA0) and a list of parameters (defined in the next section). The parameter count field in the header is always set to 2, for the status code and command tag parameters.

Byte # Parameter Descripton

0 - 3 Status code The Status codes are errors encountered during the execution of a command by the target. If a command succeeds, then a kStatus_Success code is returned.

4 - 7 Command tag The Command tag parameter identifies the response to the command sent by the host.

Table 4-11. GenericResponse parameters

GetPropertyResponse: The GetPropertyResponse packet is sent by the target in response to the host query that uses the GetProperty command. The GetPropertyResponse packet contains the framing packet data and the command packet data with the command/response tag set to the GetPropertyResponse tag value (0xA7).

Response packet

The parameter count field in the header is set to greater than 1 to always include the status code and one or many property values.

Table 4-12. GetPropertyResponse parameters

Byte #	Value	Parameter
0 - 3		Status code
4 - 7		Property value
		Can be up to a maximum of six property values, limited to the size of the 32-bit command packet and property type.

ReadMemoryResponse: The ReadMemoryResponse packet is sent by the target in a response to the host sending a ReadMemory command. The ReadMemoryResponse packet contains the framing packet data and the command packet data with the command/response tag set to the ReadMemoryResponse tag value (0xA3) and the flags field is set to kCommandFlag_HasDataPhase (1).

The parameter count set to 2 for the status code and the data byte count parameters shown here.

Table 4-13. ReadMemoryResponse parameters

Byte #	Parameter	Descripton
0 - 3	Status code	The status of the associated Read Memory command.
4 - 7	Data byte count	The number of bytes sent in the data phase.

FlashReadOnceResponse: The FlashReadOnceResponse packet is sent by the target in response to the host sending a FlashReadOnce command. The FlashReadOnceResponse packet contains the framing packet data and the command packet data with the command/response tag set to a FlashReadOnceResponse tag value (0xAF) and the flags field set to 0. The parameter count is set to 2 plus *the number of words* requested to be read in the FlashReadOnceCommand.

Table 4-14. FlashReadOnceResponse parameters

Byte #	Value	Parameter
0 – 3		Status Code
4 – 7		Byte count to read
		Can be up to 20 bytes of requested read data.

The FlashReadResourceResponse packet is sent by the target in response to the host sending a FlashReadResource command. The FlashReadResourceResponse packet contains the framing packet data and command packet data with the command/response tag set to a FlashReadResourceResponse tag value (0xB0) and the flags field set to kCommandFlag_HasDataPhase (1).

Table 4-15. FlashReadResourceResponse parameters

Byte #	Value	Parameter
0 – 3		Status Code
4 – 7		Data byte count

Response packet

Chapter 5 MCU bootloader command API

5.1 Introduction

All MCU bootloader command APIs follow the command packet format wrapped by the framing packet, as explained in the previous sections.

See Table 4-9 for a list of commands supported by the MCU bootloader.

For a list of status codes returned by the MCU bootloader, see Appendix A.

5.2 GetProperty command

The GetProperty command is used to query the bootloader about various properties and settings. Each supported property has a unique 32-bit tag associated with it. The tag occupies the first parameter of the command packet. The target returns a GetPropertyResponse packet with the property values for the property identified with the tag in the GetProperty command.

The properties are the defined units of data that can be accessed with the GetProperty or SetProperty commands. The properties may be read-only or read-write. All read-write properties are 32-bit integers, so they can easily be carried in a command parameter.

For a list of properties and their associated 32-bit property tags supported by the MCU bootloader, see Appendix B, "GetProperty and SetProperty commands".

The 32-bit property tag is the only parameter required for the GetProperty command.

 Table 5-1. Parameters for GetProperty command

Byte #	Command
0 - 3	Property tag
4 - 7	External Memory Identifier (only applies to get property for external memory)

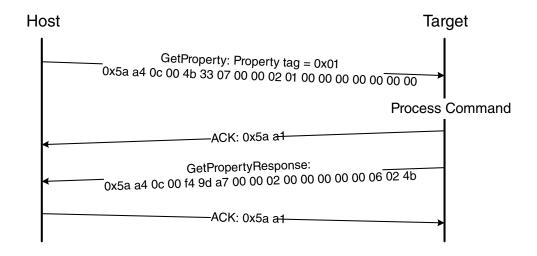


Figure 5-1. Protocol sequence for GetProperty command

lab	ole 5-2.	GetPrope	rty command	d packet forr	nat (Example)

GetProperty	Parameter	Value
Framing packet	start byte	0x5A
	packetType	0xA4, kFramingPacketType_Command
	length	0x0C 0x00
	crc16	0x4B 0x33
Command packet	commandTag	0x07 – GetProperty
	flags	0x00
	reserved	0x00
	parameterCount	0x02
	propertyTag	0x0000001 - CurrentVersion
	Memory ID	0x00000000 - Internal Flash (0x00000001 - QSPI0 Memory)

The GetProperty command has no data phase.

Response: In response to a GetProperty command, the target sends a GetPropertyResponse packet with the response tag set to 0xA7. The parameter count indicates the number of parameters sent for the property values, with the first parameter showing the status code 0, followed by the property value(s). The following table shows an example of a GetPropertyResponse packet.

Table 5-3. GetProperty Response Packet Format (Example)

GetPropertyResponse	Parameter	Value
Framing packet	start byte	0x5A
	packetType	0xA4, kFramingPacketType_Command
	length	0x0c 0x00 (12 bytes)
	crc16	0xf4 9d
Command packet	responseTag	0xA7
	flags	0x00
	reserved	0x00
	parameterCount	0x02
	status	0x0000000
	propertyValue	0x4b020600 - CurrentVersion

5.3 SetProperty command

The SetProperty command is used to change or alter the values of the properties or options of the bootloader. The command accepts the same property tags used with the GetProperty command. However, only some properties are writable--see Appendix B. If an attempt to write a read-only property is made, an error is returned indicating that the property is read-only and cannot be changed.

The property tag and the new value to set are the two parameters required for the SetProperty command.

Table 5-4. Parameters for SetProperty Command

Byte #	Command
0 - 3	Property tag
4 - 7	Property value

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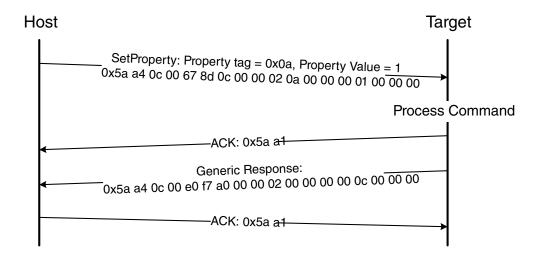


Figure 5-2. Protocol Sequence for SetProperty Command

Table 5-5. SetProperty Command Packet Format (Example)

SetProperty	Parameter	Value
Framing packet	start byte	0x5A
	packetType	0xA4, kFramingPacketType_Command
	length	0x0C 0x00
	crc16	0x67 0x8D
Command packet	commandTag	0x0C - SetProperty with property tag 10
	flags	0x00
	reserved	0x00
	parameterCount	0x02
	propertyTag	0x000000A - VerifyWrites
	propertyValue	0x0000001

The SetProperty command has no data phase.

Response: The target returns a GenericResponse packet with one of the following status codes:

Table 5-6. SetProperty Response Status Codes

Status Code	
kStatus_Success	

Table continues on the next page...

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Table 5-6. SetProperty Response Status Codes (continued)

Status Code
kStatus_ReadOnly
kStatus_UnknownProperty
kStatus_InvalidArgument

5.4 FlashEraseAll command

The FlashEraseAll command performs an erase of the entire flash memory. If any flash regions are protected, then the FlashEraseAll command fails and returns an error status code. Executing the FlashEraseAll command releases the flash security. The flash security is enabled by setting the FTFA_FSEC register. However, the FSEC field of the flash configuration field is erased, so unless it is reprogrammed, the flash security is reenabled after the next system reset. The Command tag for the FlashEraseAll command is 0x01, set in the commandTag field of the command packet.

The FlashEraseAll command requires memory ID. If the memory ID is not specified, the internal flash (memory ID =0) is selected as default.

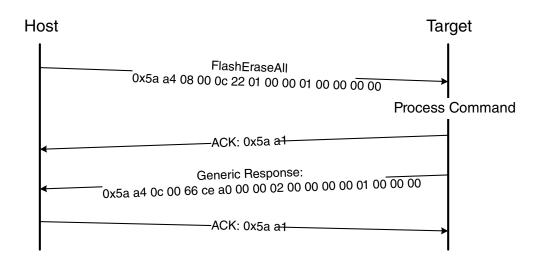


Figure 5-3. Protocol Sequence for FlashEraseAll Command

Table 5-7. FlashEraseAll Command Packet Format (Example)

FlashEraseAll	Parameter	Value
Framing packet	start byte	0x5A
	packetType	0xA4, kFramingPacketType_Command
	length	0x08 0x00
	crc16	0x0C 0x22
Command packet	commandTag	0x01 - FlashEraseAll
	flags	0x00
	reserved	0x00
	parameterCount	0x01
	Memory ID	0x00000000 - Internal Flash (0x00000001 - QSPI0 Memory)

The FlashEraseAll command has no data phase.

Response: The target returns a GenericResponse packet with the status code set to kStatus_Success for a successful execution of the command, or set to an appropriate error status code.

5.5 FlashEraseRegion command

The FlashEraseRegion command performs an erase of one or more sectors of the flash memory.

The start address and number of bytes are the two parameters required for the FlashEraseRegion command. The start and byte count parameters must be 4-byte aligned ([1:0] = 00), or the FlashEraseRegion command fails and returns kStatus_FlashAlignmentError(101). If the region specified does not fit into the flash memory space, the FlashEraseRegion command fails and returns kStatus_FlashAddressError(102). If any part of the region specified is protected, the FlashEraseRegion command fails and returns kStatus_MemoryRangeInvalid(10200).

Table 5-8. Parameters for FlashEraseRegion Command

Byte #	Parameter
0 - 3	Start address
4 - 7	Byte count
8 - 11	Memory ID

The FlashEraseRegion command has no data phase.

Response: The target returns a GenericResponse packet with one of the following error status codes.

Table 5-9. FlashEraseRegion Response Status Codes

Status Code
kStatus_Success (0)
kStatus_MemoryRangeInvalid (10200)
kStatus_FlashAlignmentError (101)
kStatus_FlashAddressError (102)
kStatus_FlashAccessError (103)
kStatus_FlashProtectionViolation (104)
kStatus_FlashCommandFailure (105)

5.6 FlashEraseAllUnsecure command

The FlashEraseAllUnsecure command performs a mass erase of the flash memory, including the protected sectors. The flash security is immediately disabled if it (flash security) was enabled, and the FSEC byte in the flash configuration field at address 0x40C is programmed to 0xFE. However, if the mass erase enable option in the FSEC field is disabled, then the FlashEraseAllUnsecure command fails.

The FlashEraseAllUnsecure command requires no parameters.

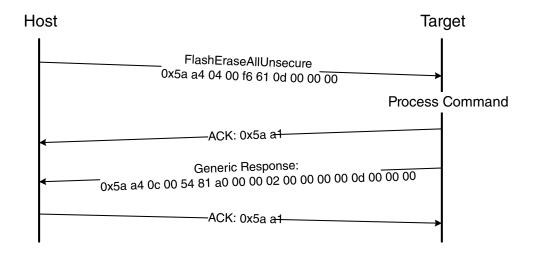


Figure 5-4. Protocol Sequence for FlashEraseAllUnsecure Command

Table 5-10. FlashEraseAllUnsecure Command Packet Format (Examp
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FlashEraseAllUnsecure	Parameter	Value
Framing packet	start byte	0x5A
	packetType	0xA4, kFramingPacketType_Command
	length	0x04 0x00
	crc16	0xF6 0x61
Command packet	commandTag	0x0D - FlashEraseAllUnsecure
	flags	0x00
	reserved	0x00
	parameterCount	0x00

The FlashEraseAllUnsecure command has no data phase.

Response: The target returns a GenericResponse packet with the status code either set to kStatus_Success for successful execution of the commandor set to an appropriate error status code.

NOTE

When the MEEN bit in the NVM FSEC register is cleared to disable the mass erase, the FlashEraseAllUnsecure command fails. FlashEraseRegion can be used instead, skipping the protected regions.

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ReadMemory command

The ReadMemory command returns the contents of the memory at the given address for a specified number of bytes. This command can read any region of memory accessible by the CPU and is not protected by security.

The start address and the number of bytes are the two parameters required for the ReadMemory command.

Table 5-11. Parameters for ReadMemory command

Byte	Parameter	Description
0 - 3	Start address	Start address of memory to read from
4 - 7	Byte count	Number of bytes to read and return to caller
8 - 11	Memory ID	Internal or external memory Identifier

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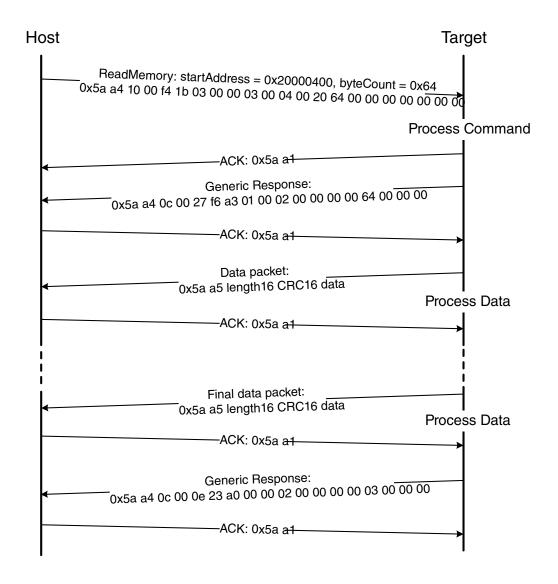


Figure 5-5. Command sequence for ReadMemory command

Table 5-12. ReadMemory packet format example

ReadMemory	Parameter	Value	
Framing packet	Start byte	0x5A0xA4,	
	packetType	kFramingPacketType_Command	
	length	0x10 00	
	crc16	0xf4 1b	
Command packet	commandTag	0x03 - readMemory	
	flags	0x00	
	reserved	0x00	
	parameterCount	0x03	

Table continues on the next page...

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Table 5-12. ReadMemory packet format example (continued)

ReadMemory	Parameter	Value
	startAddress	0x20000400
	byteCount	0x00000064
memoryID	0x0	

Data Phase: The ReadMemory command has a data phase. Because the target works in the slave mode, the host must pull the data packets until the number of bytes of data specified in the byteCount parameter of the ReadMemory command are received by the host.

Response: The target returns a GenericResponse packet with a status code either set to kStatus_Success upon a successful execution of the command, or set to an appropriate error status code.

5.8 WriteMemory command

The WriteMemory command writes the data provided in the data phase to a specified range of bytes in the memory (flash or RAM). However, if the flash protection is enabled, then the writes to the protected sectors fail.

Special care must be taken when writing to the flash.

- First, any flash sector written to must be previously erased with the FlashEraseAll, FlashEraseRegion, or FlashEraseAllUnsecure command.
- First, any flash sector written to must be previously erased with the FlashEraseAll or FlashEraseRegion command.
- Writing to the flash requires the start address to be 4-byte aligned ([1:0] = 00).
- The byte count is rounded up to a multiple of 4, and the trailing bytes are filled with the flash erase pattern (0xff).
- If the VerifyWrites property is set to true, then the writes to the flash also perform a flash verify program operation.

When writing to the RAM, the start address does not need to be aligned, and the data is not padded.

The start address and the number of bytes are the two parameters required for the WriteMemory command.

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Table 5-13. Parameters for WriteMemory Command

Byte #	Command
0 - 3	Start address
4 - 7	Byte count
8 - 11	Memory ID

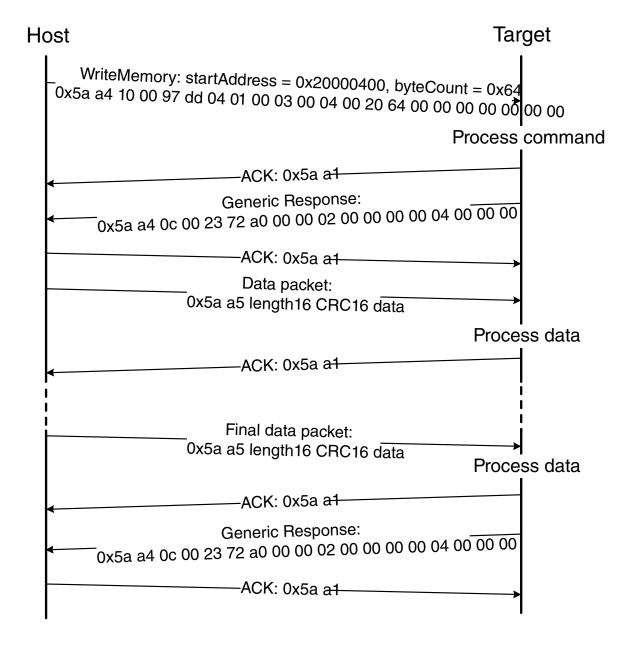


Figure 5-6. Protocol Sequence for WriteMemory Command

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Table 5-14. WriteMemory Command Packet Format (Example)

WriteMemory	Parameter	Value
Framing packet	start byte	0x5A
	packetType	0xA4, kFramingPacketType_Command
	length	0x10 00
	crc16	0x97 DD
Command packet	commandTag	0x04 - writeMemory
	flags	0x01
	reserved	0x00
	parameterCount	0x03
	startAddress	0x20000400
	byteCount	0x00000064
memoryID	0x0	

Data Phase: The WriteMemory command has a data phase; the host sends data packets until the number of bytes of data specified in the byteCount parameter of the WriteMemory command are received by the target.

Response: The target returns the GenericResponse packet with a status code set to kStatus_Success upon a successful execution of the command, or to an appropriate error status code.

5.9 FillMemory command

The FillMemory command fills a range of bytes in the memory with a data pattern. It follows the same rules as the WriteMemory command. The difference between the FillMemory and the WriteMemory is that a data pattern is included in the FillMemory command parameter, and there is no data phase for the FillMemory command, while the WriteMemory command has a data phase.

Table 5-15. Parameters for FillMemory Command

Byte #	Command
0 - 3	Start address of memory to fill
4 - 7	Number of bytes to write with the pattern The start address should be 32-bit aligned. The number of bytes must be evenly divisible by 4. (Note: for a part that uses FTFE flash, the start address should be 64-bit aligned, and the number of bytes must be evenly divisible by 8).
8 - 11	32-bit pattern

FillMemory command

- To fill with a byte pattern (8-bit), the byte must be replicated four times in the 32-bit pattern.
- To fill with a short pattern (16-bit), the short value must be replicated two times in the 32-bit pattern.

For example, to fill a byte value with 0xFE, the word pattern is 0xFEFEFEFE; to fill a short value 0x5AFE, the word pattern is 0x5AFE5AFE.

Special care must be taken when writing to the flash.

- First, any flash sector written to must be previously erased with a FlashEraseAll or FlashEraseRegion, or FlashEraseAllUnsecure command.
- Writing to the flash requires the start address to be 4-byte aligned.
- If the VerifyWrites property is set to true, then a write to the flash also performs a flash verify program operation.

When writing to the RAM, the start address does not need to be aligned, and the data is not padded.

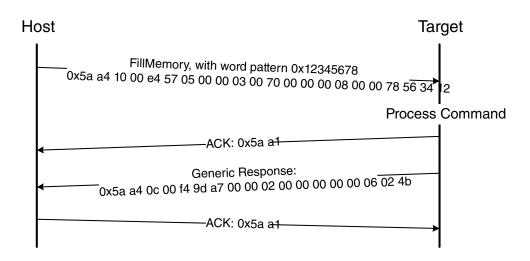


Figure 5-7. Protocol Sequence for FillMemory Command

Table 5-16. FillMemory Command Packet Format (Example)

FillMemory	Parameter	Value
Framing packet	start byte	0x5A
	packetType	0xA4, kFramingPacketType_Command
	length	0x10 0x00
	crc16	0xE4 0x57

Table continues on the next page...

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Table 5-16. FillMemory Command Packet Format (Example) (continued)

FillMemory	Parameter	Value
Command packet	commandTag	0x05 – FillMemory
	flags	0x00
	Reserved	0x00
	parameterCount	0x03
	startAddress	0x00007000
	byteCount	0x00000800
	patternWord	0x12345678

The FillMemory command has no data phase.

Response: upon a successful execution of the command, the target (MCU bootloader) returns a GenericResponse packet with a status code set to kStatus_Success, or to an appropriate error status code.

5.10 FlashSecurityDisable command

The FlashSecurityDisable command performs the flash security disable operation by comparing the 8-byte backdoor key (provided in the command) against the backdoor key stored in the flash configuration field (at address 0x400 in the flash).

The backdoor low and high words are the only parameters required for the FlashSecurityDisable command.

Table 5-17. Parameters for FlashSecurityDisable Command

Byte #	Command
0 - 3	Backdoor key low word
4 - 7	Backdoor key high word

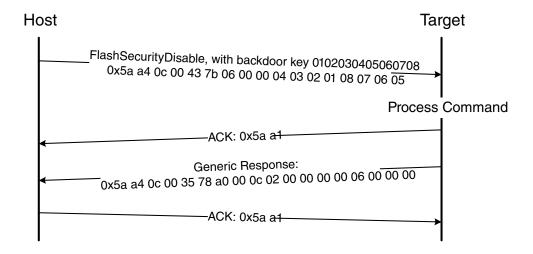


Figure 5-8. Protocol Sequence for FlashSecurityDisable Command

 Table 5-18.
 FlashSecurityDisable Command Packet Format (Example)

FlashSecurityDisable	Parameter	Value
Framing packet	start byte	0x5A
	packetType	0xA4, kFramingPacketType_Command
	length	0x0C 0x00
	crc16	0x43 0x7B
Command packet	commandTag	0x06 - FlashSecurityDisable
	flags	0x00
	reserved	0x00
	parameterCount	0x02
	Backdoorkey_low	0x04 0x03 0x02 0x01
	Backdoorkey_high	0x08 0x07 0x06 0x05

The FlashSecurityDisable command has no data phase.

Response: The target returns a GenericResponse packet with a status code either set to kStatus_Success upon a successful execution of the command, or set to an appropriate error status code.

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5.11 Execute command

The execute command results in the bootloader setting the program counter to the code at the provided jump address, R0 to the provided argument, and a Stack pointer to the provided stack pointer address. Before the jump, the system is returned to the reset state.

The Jump address, function argument pointer, and stack pointer are the parameters required for the Execute command. If the stack pointer is set to zero, the called code is responsible for setting the processor stack pointer before using the stack.

If the QSPI is enabled, it is initialized before the jump. The QSPI encryption (OTFAD) is also enabled (if configured).

Byte #	Command
0 - 3	Jump address
4 - 7	Argument word
8 - 11	Stack pointer address

Table 5-19. Parameters for Execute Command

The Execute command has no data phase.

Response: Before executing the Execute command, the target validates the parameters and returns a GenericResponse packet with a status code either set to kStatus_Success or an appropriate error status code.

5.12 Call command

The Call command executes a function that is written in the memory at the address sent in the command. The address must be be a valid memory location residing in the accessible flash (internal or external) or in the RAM. The command supports the passing of one 32-bit argument. Although the command supports a stack address, at this time, the call still takes place using the current stack pointer. After the execution of the function, a 32-bit return value is returned in the generic response message.

The QSPI must be initialized before executing the Call command if the call address is on the QSPI. The Call command does not initialize the QSPI.

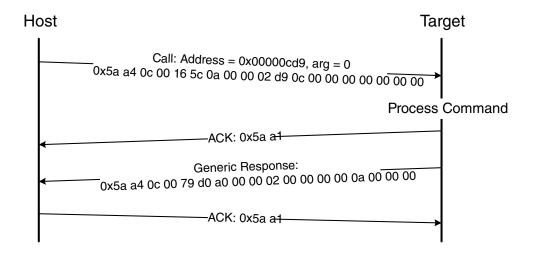


Figure 5-9. Protocol sequence for call command

Table 5-20. Parameters for Call Command

Byte #	Command
0 - 3	Call address
4 - 7	Argument word
8 - 11	Stack pointer

Response: The target returns a GenericResponse packet with a status code either set to the return value of the function called or set to kStatus_InvalidArgument (105).

5.13 Reset command

The Reset command results in the bootloader resetting the chip.

The Reset command requires no parameters.

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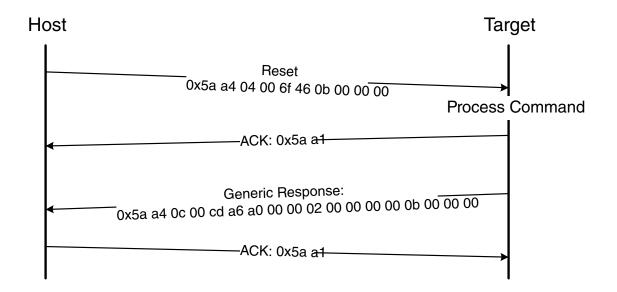


Figure 5-10. Protocol Sequence for Reset Command

Reset	Parameter	Value
Framing packet	start byte	0x5A
	packetType	0xA4, kFramingPacketType_Command
	length	0x04 0x00
	crc16	0x6F 0x46
Command packet	commandTag	0x0B - reset
	flags	0x00
	reserved	0x00
	parameterCount	0x00

The Reset command has no data phase.

Response: The target returns a GenericResponse packet with a status code set to kStatus_Success before resetting the chip.

The Reset command can also be used to switch the boot from the flash after a successful flash image provisioning via the ROM bootloader. After issuing the reset command, wait five seconds for the user application to start running from the flash.

5.14 FlashProgramOnce command

The FlashProgramOnce command writes the data (that is provided in a command packet) to a specified range of bytes in the program once field. Special care must be taken when writing to the program once field.

- The program once field only supports programming once, so any attempts to reprogram a program once field get an error response.
- Writing to the program once field requires the byte count to be 4-byte aligned or 8-byte aligned.

The FlashProgramOnce command uses three parameters: index 2, byteCount, data.

Byte #	Command
0 - 3	Index of program once field
4 - 7	Byte count (must be evenly divisible by 4)
8 - 11	Data
12 - 16	Data

Table 5-22. Parameters for FlashProgramOnce Command

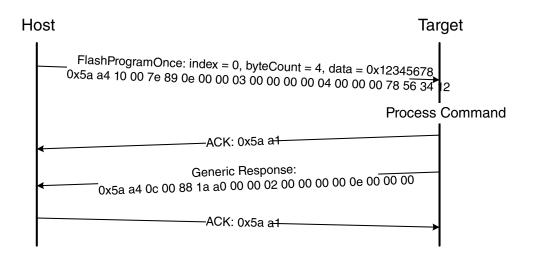


Figure 5-11. Protocol Sequence for FlashProgramOnce Command

Table 5-23. FlashProgramOnce Command Packet Format (Example)

FlashProgramOnce	Parameter	Value
Framing packet	start byte	0x5A
	packetType	0xA4, kFramingPacketType_Command
	length	0x10 0x00
	crc16	0x7E4 0x89
Command packet	commandTag	0x0E - FlashProgramOnce
	flags	0
	reserved	0
	parameterCount	3
	index	0x0000_0000
	byteCount	0x0000_0004
	data	0x1234_5678

Response: upon a successful execution of the command, the target (MCU bootloader) returns a GenericResponse packet with a status code set to kStatus_Success, or to an appropriate error status code.

5.15 FlashReadOnce command

The FlashReadOnce command returns the contents of the program once field by the given index and byte count. The FlashReadOnce command uses two parameters: index and byteCount.

Table 5-24. Parameters for FlashReadOnce Command

	Byte #	Parameter	Description
Ī	0 - 3	index	Index of the program once field (to read from)
	4 - 7	byteCount	Number of bytes to read and return to the caller

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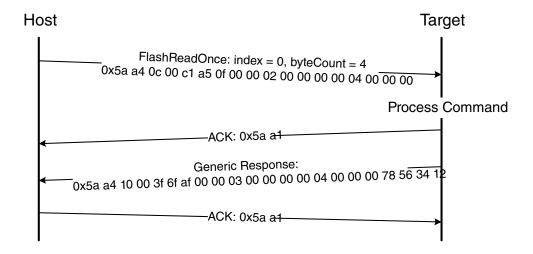


Figure 5-12. Protocol Sequence for FlashReadOnce Command

Table 5-25. FlashReadOnce Command Packet Format (Example)

FlashReadOnce	Parameter	Value
Framing packet	start byte	0x5A
	packetType	0xA4
	length	0x0C 0x00
	crc	0xC1 0xA5
Command packet	commandTag	0x0F - FlashReadOnce
	flags	0x00
	reserved	0x00
	parameterCount	0x02
	index	0x0000_0000
	byteCount	0x0000_0004

Table 5-26. FlashReadOnce Response Format (Example)

FlashReadOnce Response	Parameter	Value
Framing packet	start byte	0x5A
	packetType	0xA4
	length	0x10 0x00
	crc	0x3F 0x6F
Command packet	commandTag	0xAF
	flags	0x00

Table continues on the next page...

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Table 5-26. FlashReadOnce Response Format (Example) (continued)

FlashReadOnce Response	Parameter	Value
	reserved	0x00
	parameterCount	0x03
	status	0x0000_0000
	byteCount	0x0000_0004
	data	0x1234_5678

Response: upon a successful execution of the command, the target returns a FlashReadOnceResponse packet with a status code set to kStatus_Success, a byte count and corresponding data read from the Program Once Field upon a successful execution of the command, or a status code set to an appropriate error status code and a byte count set to 0.

FlashReadResource command 5.16

The FlashReadResource command returns the contents of the IFR field or the Flash firmware ID by the given offset, byte count, and option. The FlashReadResource command uses three parameters: start address, byteCount, and option.

Table 5-27. Parameters for FlashReadResource Command

Byte #	Parameter	Command
0 - 3	start address	Start address of specific non-volatile memory to be read
4 - 7	byteCount	Byte count to be read
8 - 11	option	0: IFR
		1: Flash firmware ID

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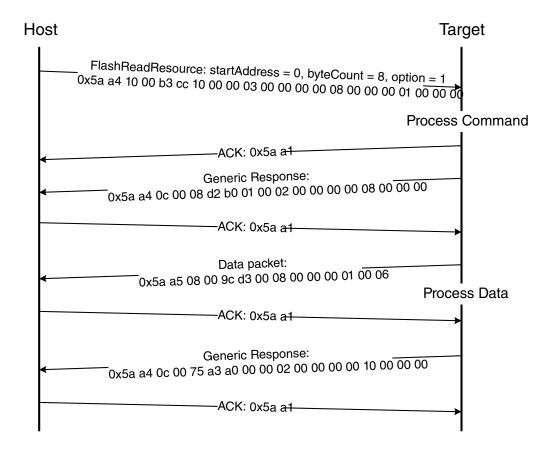


Figure 5-13. Protocol Sequence for FlashReadResource Command

Table 5-28. FlashReadResource Command Packet Format (Example)

FlashReadResource	Parameter	Value				
Framing packet	start byte	0x5A				
	packetType	0xA4				
	length	0x10 0x00				
	crc	0xB3 0xCC				
Command packet	commandTag	0x10 - FlashReadResource				
	flags	0x00				
	reserved	0x00				
	parameterCount	0x03				
	startAddress	0x0000_0000				
	byteCount	0x0000_0008				
	option	0x0000_0001				

Table 5-29. FlashReadResource Response Format (Example)

FlashReadResource Response	Parameter	Value
Framing packet	start byte	0x5A
	packetType	0xA4
	length	0x0C 0x00
	crc	0xD2 0xB0
Command packet	commandTag	0xB0
	flags	0x01
	reserved	0x00
	parameterCount	0x02
	status	0x0000_0000
	byteCount	0x0000_0008

Data phase: The FlashReadResource command has a data phase. Because the target (MCU bootloader) works in a slave mode, the host must pull the data packets until the number of bytes of data *specified in the byteCount parameter of FlashReadResource command* is received by the host.

5.17 Configure Memory command

The Configure Memory command configures the external memory device using a preprogrammed configuration image. The parameters passed in the command are the memory ID (which should be 1 QuadSPI Nor Memory) and the memory address from which the configuration data can be loaded from. The options for loading the data can be a scenario where the configuration data is written to a RAM or flash location and this command directs the bootloader to use the data at that location to configure the external memory devices.

Table 5-30. Parameters for Configure QuadSPI Command

Byte #	Command
0 – 3	Memory ID
4 – 7	Configuration block address

Response: The target (MCU bootloader) returns a GenericResponse packet with a status code either set to kStatus_Success upon a successful execution of the command, or set to an appropriate error code.

5.18 ReceiveSBFile command

The ReceiveSBFile command starts the transfer of an SB file to the target. The command only specifies the size of the SB file that is sent in the data phase (in bytes). The SB file is processed as it is received by the bootloader.

Table 5-31. Parameters for ReceiveSBFile Command

Byte #	Command
0 - 3	Byte count

Data Phase: The ReceiveSBFile command has a data phase. The host sends data packets until the number of bytes of data specified in the byteCount parameter of the ReceiveSBFile command are received by the target.

Response: The target returns a GenericResponse packet with a status code set to kStatus_Success upon a successful execution of the command or set to an appropriate error code.

5.19 ReliableUpdate command

The ReliableUpdate command performs the reliable update operation.

- For a software implementation: the backup application address is the parameter that is required for the ReliableUpdate command. If the *backup address* is set to 0, then the bootloader uses the *predefined address*.
- For a hardware implementation: the swap indicator address is the parameter that is required for the ReliableUpdate command.
 - If the flash swap system is **uninitialized**, then the swap indicator address can be arbitrarily specified.
 - If the flash swap system is **initialized**, then the swap indicator must be aligned with the swap system.

Table 5-32. Parameters for ReliableUpdate command

Byte number	Command
0 - 3	 For a software implementation: the value is the backup application address. For a hardware implementation: the value is the swap indicator address.

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Response: The target returns a GenericResponse packet with a status code either set to kStatus_Success upon a successful execution of the command, or set to an appropriate error status code.

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ReliableUpdate command

Chapter 6 Supported peripherals

6.1 Introduction

This section describes the peripherals supported by the MCU bootloader. To use an interface for bootloader communications, the peripheral must be enabled in the BCA. If the BCA is invalid (for example, all 0xFF bytes), then all peripherals are enabled by default.

6.2 I2C peripheral

The MCU bootloader supports loading data into flash via the I2C peripheral, where the I2C peripheral serves as the I2C slave. A 7-bit slave address is used during the transfer.

Customizing an I2C slave address is also supported. This feature is enabled if the Bootloader Configuration Area (BCA) is enabled (tag field is filled with 'kcfg') and the i2cSlaveAddress field is filled with a value other than 0xFF. Otherwise, 0x10 is used as the default I2C slave address.

The MCU bootloader uses 0x10 as the I2C slave address, and supports 400 kbit/s as the I2C baud rate.

The maximum supported I2C baud rate depends on corresponding clock configuration field in the BCA. The typical baud rate is 400 kbit/s with factory settings. The actual supported baud rate may be lower or higher than 400 kbit/s, depending on the actual value of the clockFlags and the clockDivider fields.

Because the I2C peripheral serves as an I2C slave device, each transfer should be started by the host, and each outgoing packet should be fetched by the host.

• An incoming packet is sent by the host with a selected I2C slave address and the direction bit is set as write.

I2C peripheral

- An outgoing packet is read by the host with a selected I2C slave address and the direction bit is set as read.
- 0x00 is sent as the response to host if the target is busy with processing or preparing data.

The following charts show the communication flow of the host reading the ping and ACK packets, and the corresponding responses from the target.

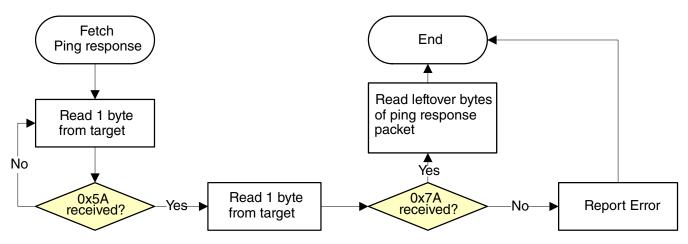


Figure 6-1. Host reads ping response from target via I2C

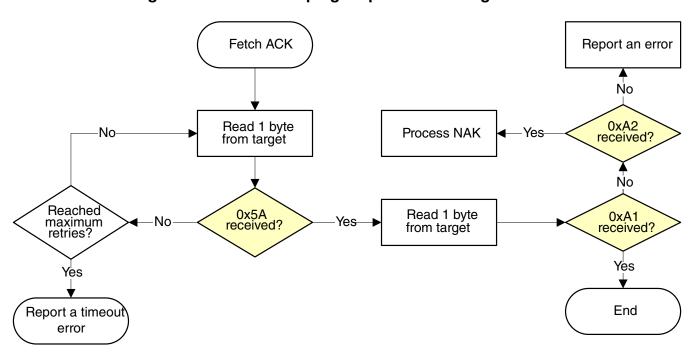


Figure 6-2. Host reads ACK packet from target via I2C

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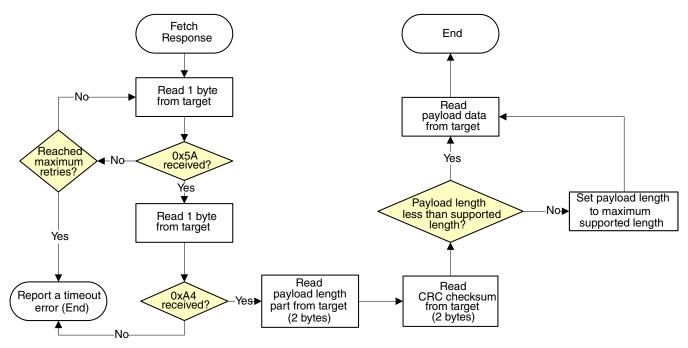


Figure 6-3. Host reads response from target via I2C

6.2.1 Performance numbers for I2C

The table below provides reference to the expected performance of write speeds to Flash and RAM memories using the MCU bootloader I2C interface. The numbers have been measured on a number of platforms running the MCU bootloader from either ROM or RAM (for flashloaders).

Table 6-1. Performance numbers for I2C

I2C Bus Frequen cy (KHz)	Flash Average Writing Speed (KB/s)							Ram Average Writing Speed (KB/s)					
	KL27	KL28	KL43	KL80	K80	KL03	KL27	KL28	KL43	KL80	K80	KL03	
100	6.42	6.29	6.42	6.7	6.39	6.08	7.67	7.27	7.7	7.91	7.38	6.13	
200	10.24	10.08	10.13	10.58	9.82	8.75	14.02	13.25	13.78	14.15	13.43	10.1	
300	12.86	11.84	11.95	13.11	11.85	9.69	18.04	17.51	17.92	18.98	17.61	11.9	
400	15.54	14.06	14.39	14.74	13.44	10.24	23.2	22.39	21.82	24.19	22.04	12.82	
500	15.86	16.13	15.96	16.94	14.65	-	24.61	27.9	26.5	30.26	26.93	-	
600	18.14	16.51	16.4	17.19	15.19	-	29.44	28.64	27.05	30.96	27.57	-	
800	19.5	-	18.51	19.22	16.26	-	34.44	-	33.38	38.36	32.72	-	
1000	20.48	-	20.03	21.35	17.71	-	37.64	-	41.04	45.38	33.65	-	

Table continues on the next page...

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Table 6-1. Performance numbers for I2C (continued)

Default core Frequen cy (MHz)	48	48	48	48	48	8	48	48	48	48	48	8
Default bus Frequen cy (MHz)	24	24	24	24	24	4	24	24	24	24	24	4

NOTE

- 1. Every test covers all flash or RAM regions with 0x0 0xf.
- 2. Run every test three times and calculate the average.

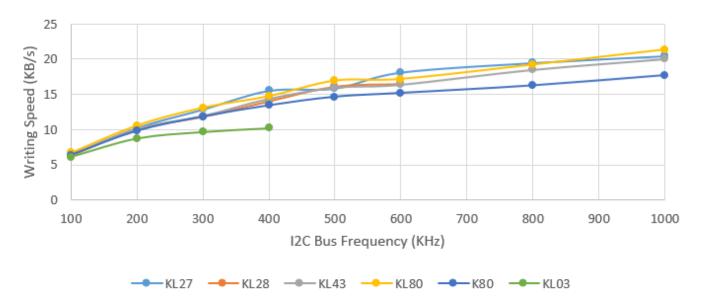


Figure 6-4. Flash Average Writing Speed

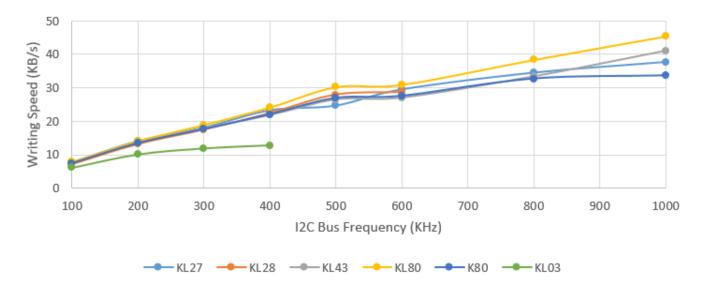


Figure 6-5. RAM Average Writing Speed

6.3 SPI Peripheral

The MCU bootloader supports loading data into flash via the SPI peripheral, where the SPI peripheral serves as a SPI slave.

The maximum supported baud rate of the SPI depends on the clock configuration fields in the Bootloader Configuration Area (BCA). The typical baud rate is 400 kbit/s with the factory settings. The actual baud rate is lower or higher than 400 kbit/s, depending on the actual value of the clockFlags and clockDivider fields in the BCA.

Because the SPI peripheral serves as a SPI slave device, each transfer should be started by the host, and each outgoing packet should be fetched by the host.

The transfer on SPI is slightly different from I2C:

- Host receives 1 byte after it sends out any byte.
- Received bytes should be ignored when host is sending out bytes to target
- Host starts reading bytes by sending 0x00s to target
- The byte 0x00 is sent as response to host if target is under the following conditions:
 - Processing incoming packet
 - Preparing outgoing data
 - Received invalid data

The following flowcharts show how the host reads a ping response, an ACK and a command response from target via SPI.

SPI Peripheral

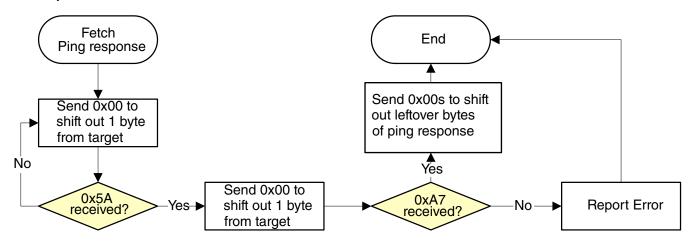


Figure 6-6. Host reads ping packet from target via SPI

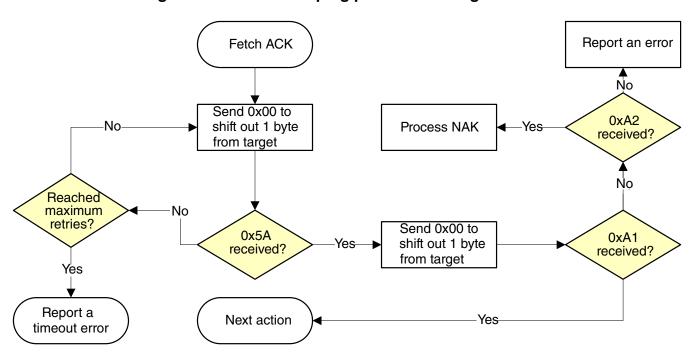


Figure 6-7. Host reads ACK from target via SPI

Chapter 6 Supported peripherals

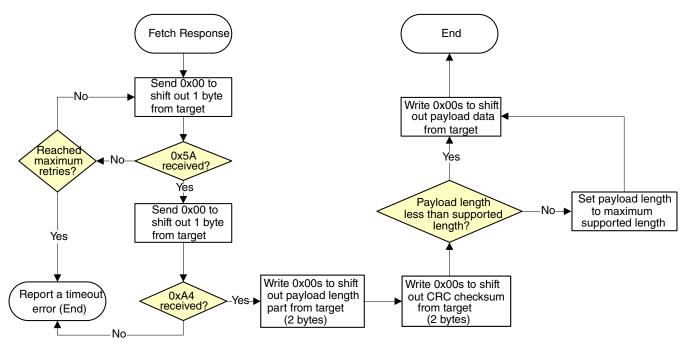


Figure 6-8. Host reads response from target via SPI

6.3.1 **Performance Numbers for SPI**

The table below provides reference to the expected performance of write speeds to Flash and RAM memories using the MCU bootloader SPI interface. The numbers were measured on a number of platforms running the MCU bootloader from either the ROM or the RAM (for flashloaders).

Table 6-2. Performance numbers SPI

		Flash Average Writing Speed (KB/s)							Ram Average Writing Speed (KB/s)				
Frequen cy (KHz)	KL27	KL28	KL43	KL80	K80	KL03	KL27	KL28	KL43	KL80	K80	KL03	
100	7.07	7.46	7.24	6.74	6.71	6.20	8.60	9.25	9.01	8.46	8.04	6.80	
200	11.45	12.26	11.88	11.53	10.18	8.87	15.23	17.98	17.04	16.17	14.19	10.64	
300	13.84	15.17	14.70	15.08	12.42	-	19.91	25.11	23.06	24.65	18.79	-	
400	16.42	18.09	17.23	16.91	13.74	-	25.89	32.95	31.15	28.89	23.95	-	
500	18.26	19.82	18.17	18.94	14.98	-	31.47	40.10	36.61	36.61	27.83	-	
600	18.72	20.72	19.98	20.63	15.21	-	32.40	44.98	40.96	42.26	27.67	-	
800	21.19	22.06	22.27	22.04	16.11	-	39.83	50.00	51.54	49.98	30.15	-	
1000	22.07	23.74	23.80	22.92	15.99	-	45.83	61.19	55.92	56.34	29.11	-	

Table continues on the next page...

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Table 6-2. Performance numbers SPI (continued)

Default core Frequen cy (MHz)	48	48	48	48	48	8	48	48	48	48	48	8
Default bus Frequen cy (MHz)		24	24	24	24	4	24	24	24	24	24	4

- 1. Every test covers all flash or RAM regions with 0x0 0xf.
- 2. Run every test three times and calculate the average.

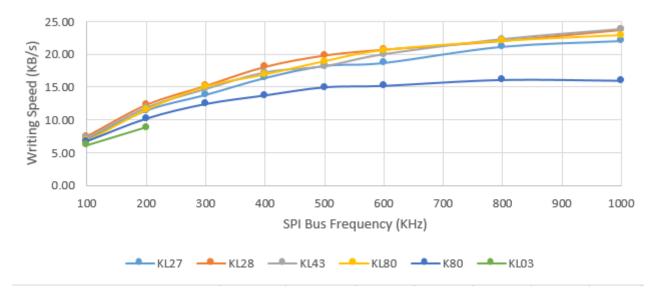


Figure 6-9. Flash Average Writing Speed

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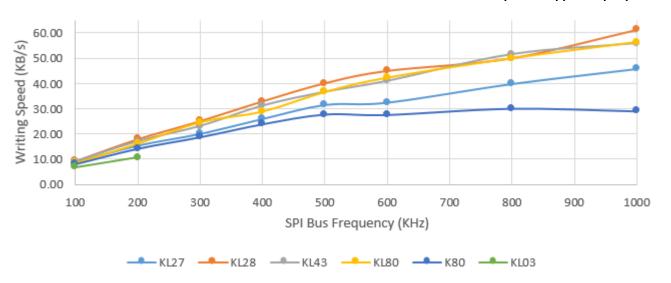


Figure 6-10. RAM Average Writing Speed

6.4 UART peripheral

The MCU bootloader integrates an autobaud detection algorithm for the UART peripheral, thereby providing flexible baud rate choices.

Autobaud feature: If UARTn is used to connect to the bootloader, then the UARTn_RX pin must be kept high and not left floating during the detection phase in order to comply with the autobaud detection algorithm. After the bootloader detects the ping packet $(0x5A\ 0xA6)$ on UARTn_RX, the bootloader firmware executes the autobaud sequence. If the baudrate is successfully detected, then the bootloader sends a ping packet response $[(0x5A\ 0xA7)$, protocol version (4 bytes), protocol version options (2 bytes), and crc16 (2 bytes)] at the detected baudrate. The MCU bootloader then enters a loop, waiting for bootloader commands via the UART peripheral.

NOTE

The data bytes of the ping packet must be sent continuously (with no more than 80 ms between bytes) in a fixed UART transmission mode (8-bit data, no parity bit, and 1 stop bit). If the bytes of the ping packet are sent one-by-one with more than an 80 ms delay between them, then the autobaud detection algorithm may calculate an incorrect baud rate. In this instance, the autobaud detection state machine should be reset.

Supported baud rates: The baud rate is closely related to the MCU core and system clock frequencies. Typical baud rates supported are 9600, 19200, 38400, and 57600. Of course, to influence the performance of autobaud detection, the clock configuration in BCA can be changed.

UART peripheral

Packet transfer: After autobaud detection succeeds, bootloader communications can take place over the UART peripheral. The following flow charts show:

- How the host detects an ACK from the target
- How the host detects a ping response from the target
- How the host detects a command response from the target

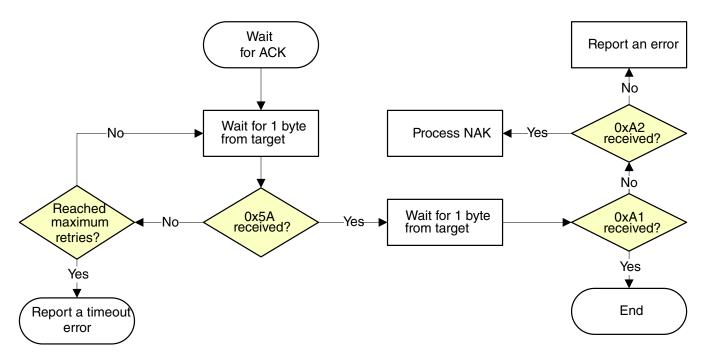


Figure 6-11. Host reads an ACK from target via UART

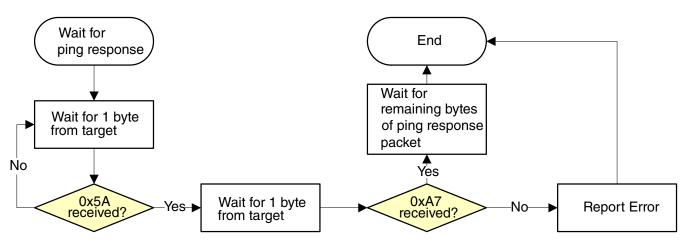


Figure 6-12. Host reads a ping response from target via UART

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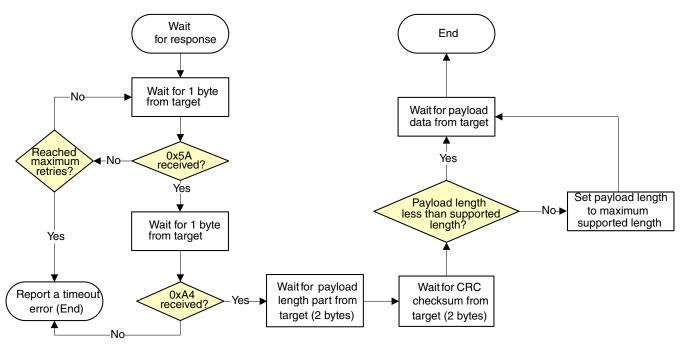


Figure 6-13. Host reads a command response from target via UART

6.4.1 **Performance Numbers for UART**

The table below provides reference to the expected performance of write speeds to Flash and RAM memories using the MCU bootloader SPI interface. The numbers have been measured on a number of platforms running the MCU bootloader either from ROM or the RAM (in case of flashloaders).

Table 6-3. Performance numbers for UART

UART	Flash Average Writing Speed (KB/s)						Ram Average Writing Speed (KB/s)							
Baud Rate	KL27	KL28	KL43	KL80	K80	KL03	KS22	KL27	KL28	KL43	KL80	K80	KL03	KS22
19200	1.47	1.47	1.43	1.47	1.46	1.43	1.45	1.51	1.52	1.48	1.52	1.52	1.49	1.51
38400	2.81	2.82	2.75	2.82	2.79	2.81	2.75	2.99	3.03	2.95	3.03	3.03	2.9	3.00
57600	4.07	4.07	3.97	4.08	4.01	-	3.93	4.46	4.53	4.4	4.54	4.51	-	4.47
11520 0	7.3	7.31	7.12	7.35	7.1	-	6.88	8.69	8.97	8.65	8.98	8.85	-	8.73
23040 0	12.14	-	11.83	12.27	11.42	-	11.01	16.57	-	16.77	17.58	16.73	-	16.65
Default core Freque ncy (MHz)	48	48	48	48	48	8	48	48	48	48	48	48	8	48

Table continues on the next page...

Table 6-3. Performance numbers for UART (continued)

Default	24	24	24	24	24	4	24	24	24	24	24	24	4	24
bus														
Freque														
ncy														
(MHz)														

- 1. Every test covers all flash or RAM region with 0x0 0xf.
- 2. Run every test three times and calculate the average.

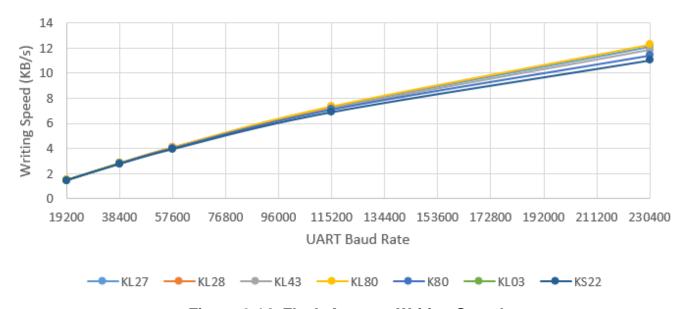


Figure 6-14. Flash Average Writing Speed

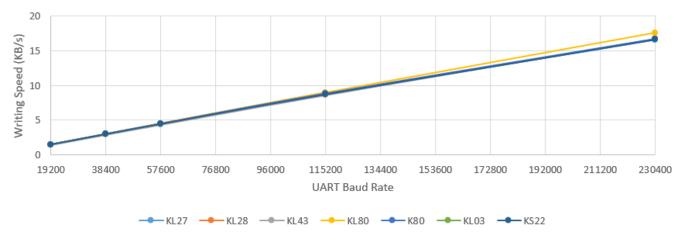


Figure 6-15. RAM Average Writing Speed

6.5 USB HID Peripheral

The MCU bootloader supports loading data into flash via the USB peripheral. The target is implemented as a USB HID class.

USB HID does not use framing packets; instead the packetization inherent in the USB protocol itself is used. The ability for the device to NAK Out transfers (until they can be received) provides the required flow control; the built-in CRC of each USB packet provides the required error detection.

6.5.1 Device descriptor

The MCU bootloader configures the default USB VID/PID/Strings as below:

Default VID/PID:

For legacy FSL devices:

- VID = 0x15A2
- PID = 0x0073

For NXP devices:

- VID = 0x1FC9
- PID = 0x007F

Default Strings:

- For legacy FSL devices:
 - Manufacturer [1] = "Freescale Semiconductor Inc."
 - Product [2] = "Kinetis bootloader"
- For NXP devices:
 - Manufacturer [1] = "NXP Semiconductor Inc."
 - Product [2] = "Kinetis bootloader"

The USB VID, PID, and Strings can be customized using the Bootloader Configuration Area (BCA) of the flash. For example, the USB VID and PID can be customized by writing the new VID to the usbVid(BCA + 0x14) field and the new PID to the usbPid(BCA + 0x16) field of the BCA in flash. To change the USB strings, prepare a structure (like the one shown below) in the flash, and then write the address of the structure to the usbStringsPointer(BCA + 0x18) field of the BCA.

6.5.2 Endpoints

The HID peripheral uses 3 endpoints:

- Control (0)
- Interrupt IN (1)
- Interrupt OUT (2)

The Interrupt OUT endpoint is optional for HID class devices, but the MCU bootloader uses it as a pipe, where the firmware can NAK send requests from the USB host.

6.5.3 HID reports

There are 4 HID reports defined and used by the bootloader USB HID peripheral. The report ID determines the direction and type of packet sent in the report; otherwise, the contents of all reports are the same.

Report ID	Packet Type	Direction
1	Command	OUT
2	Data	OUT
3	Command	IN
4	Data	IN

For all reports, these properties apply:

Usage Min	1
Usage Max	1
Logical Min	0
Logical Max	255
Report Size	8
Report Count	34

Each report has a maximum size of 34 bytes. This is derived from the minimum bootloader packet size of 32 bytes, plus a 2-byte report header that indicates the length (in bytes) of the packet sent in the report.

NOTE

In the future, the maximum report size may be increased, to support transfers of larger packets. Alternatively, additional reports may be added with larger maximum sizes.

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The actual data sent in all of the reports looks like:

0	Report ID
1	Packet Length LSB
2	Packet Length MSB
3	Packet[0]
4	Packet[1]
5	Packet[2]
N+3-1	Packet[N-1]

This data includes the Report ID, which is required if more than one report is defined in the HID report descriptor. The actual data sent and received has a maximum length of 35 bytes. The Packet Length header is written in little-endian format, and it is set to the size (in bytes) of the packet sent in the report. This size does not include the Report ID or the Packet Length header itself. During a data phase, a packet size of 0 indicates a data phase abort request from the receiver.

6.6 USB peripheral

The MCU bootloader supports loading data into flash or RAM using the USB peripheral. The target is implemented as USB-HID and USB MSC (Mass Storage Class) composite device classes.

When transfer data through USB-HID device class, USB-HID does not use framing packets. Instead, the packetization, inherent in the USB protocol itself, is used. The ability for the device to NAK Out transfers (until they can be received) provides the required flow control. The built-in CRC of each USB packet provides the required error detection.

When transfer data through USB MSC device class, USB MSC does not use framing packets. Instead, the packetization, inherent in the USB protocol itself, is used. As with any mass storage class device, a device drive letter appears in the file manager of the operating system, and the file image can be dragged and dropped to the storage device. Right now, the USB MSC download only supports SB file drag-and-drop. Reading the SB file from the MSC device is not supported.

The USB peripheral can work as HID + MSC in Composite device mode. For HID-only mode or MSC-only mode, this is configured using macros during compile time. If configured as the HID and MSC composite device, users can either send commands to the HID interface, or drag/drop SB files to the MSC device.

6.7 FlexCAN Peripheral

The MCU Bootloader supports loading data into flash via the FlexCAN peripheral.

It supports four predefined speeds on FlexCAN transferring:

- 125 KHz
- 250 KHz
- 500 KHz
- 1 MHz

The curent FlexCAN IP can support up to 1 MHz speed, so the default speed is set to 1 MHz.

In host applications, the user can specify the speed for FlexCAN by providing the speed index as 0 through 4, which represents those 5 speeds.

In bootloader, this supports the auto speed detection feature within supported speeds. In the beginning, the bootloader enters the listen mode with the initial speed (default speed 1 MHz). Once the host starts sending a ping to a specific node, it generates traffic on the FlexCAN bus. Because the bootloader is in a listen mode. It is able to check if the local node speed is correct by detecting errors. If there is an error, some traffic will be visible, but it may not be on the right speed to see the real data. If this happens, the speed setting changes and checks for errors again. No error means the speed is correct. The settings change back to the normal receiving mode to see if there is a package for this node. It then stays in this speed until another host is using another speed and try to communicate with any node. It repeats the process to detect a right speed before sending host timeout and aborting the request.

The host side should have a reasonable time tolderance during the auto speed detect period. If it sends as timeout, it means there is no response from the specific node, or there is a real error and it needs to report the error to the application.

This flow chart shows the communication flow for how the host reads the ping packet, ACK, and response from the target.

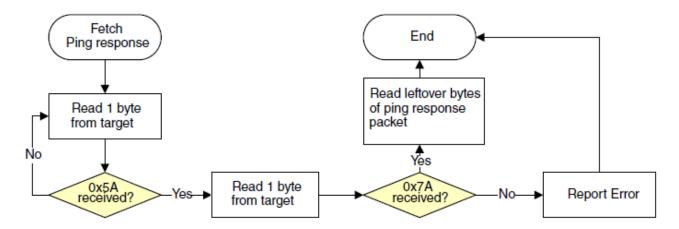


Figure 6-16. Host reads ping response from target via FlexCAN

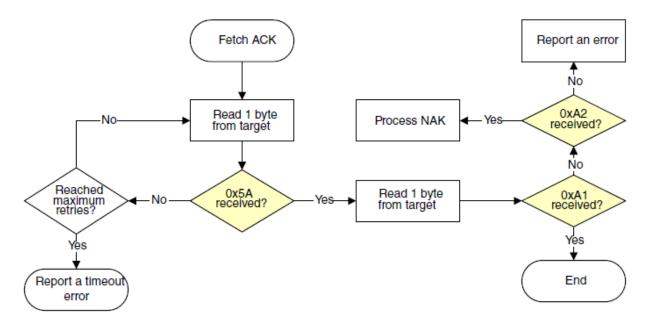


Figure 6-17. Host reads ACK packet from target via FlexCAN

QuadSPI Peripheral

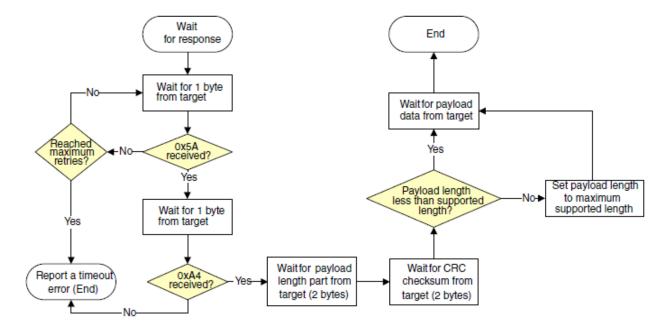


Figure 6-18. Host reads command response from target via FlexCAN

QuadSPI Peripheral 6.8

The MCU Bootloader supports read, write, and erase external SPI flash devices (QuadSPI memory) via the QuadSPI module. It supports booting directly to external SPI flash and XIP in QuadSPI memory. Before accessing external SPI flash devices, the QuadSPI module must be configured properly, using the OSPI configuration block.

QSPI configuration block 6.8.1

The OSPI config block (QCB) provides many configuration parameters, which are intended to support many types of serial flash. All fields in the QSPI config block must be configured according to the specific flash device provided by your specific vendor, and all of them are related to the configuration for registers in the QuadSPI module. Also see the QuadSPI chapter.

NOTE

To correctly configure the QuadSPI, all unused QuadSPI configuration fields should be set to 0.

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Table 6-4. Configuration fields in QSPI config block

Size (bytes)	Configuration Field	Description
4	tag	A magic number to verify whether the QSPI config block (QCB) is valid. Must be set to 'kqcf'
		[31:24] - 'f' (0x66)
		[23:16] - 'c' (0x63)
		[15: 8] - 'q'(0x71)
		[7: 0] - 'k'(0x6B)
4	version	Version number of the QSPI config block
		[31:24] - name: must be 'Q' (0x51)
		[23:16] - major: must be 1
		[15: 8] - minor: must be 0
		[7: 0] - bugfix: must be 0
4	lengthInBytes	Size of QSPI config block, in bytes
		Must be 512
4	dqs_loopback	Enable DQS loopback support
		0 DQS loopback is disabled
		1 DQS loopback is enabled, the DQS loopback mode is determined by subsequent 'dqs_loopback_internal' field
4	data_hold_time	Serial flash data hold time. Valid value 0/1/2. See the QuadSPI chapter for details.
8	-	Reserved
4	device_mode_config_en	Configure work mode Enable for external SPI flash devices
		0 Disabled - ROM will not configure work mode of external flash devices.
		1 Enabled - ROM will configure work mode of external flash devices, based on "device_cmd" and the LUT entry indicated by" write_cmd_ipcr".
4	device_cmd	Command to configure the work mode of external flash devices. Effective only if "device_mode_config_en" is set to 1. It also depends on your specific external SPI flash device.
4	write_cmd_ipcr	IPCR pointed to LUT index for quad mode enablement
		Value = index << 24
4	word_addressable	Word Addressable
		0 Byte-addressable serial flash mode
		1 Word-addressable serial flash mode
4	cs_hold_time	Serial flash CS hold time, in number of flash clock cycles
4	cs_setup_time	Serial flash CS setup time, in number of flash clock cycles
	4 4 4 4 4 4 4 4	tag 4 tag 4 version 4 lengthInBytes 4 dqs_loopback 4 data_hold_time 8 - 4 device_mode_config_en 4 write_cmd_ipcr 4 word_addressable 4 cs_hold_time

Table continues on the next page...

QuadSPI Peripheral

Table 6-4. Configuration fields in QSPI config block (continued)

Offset	Size (bytes)	Configuration Field	Description
0x34 - 0x37	4	sflash_A1_size	Size of external flash connected to ports of QSPI0A and QSPI0A_CS0, in bytes
0x38 - 0x3b	4	sflash_A2_size	Size of external flash connected to ports of QSPI0A and quadSPI0A_CS1, in bytes
			sflash_A2_size field must be set to 0 if the serial flash device is not present.
0x3c - 0x3f	4	sflash_B1_size	Size of external flash connected to ports of QSPI0B and quadSPI0B_CS0, in bytes
			sflash_B1_size field must be set to 0 if the serial flash device is not present.
0x40 - 0x43	4	sflash_B2_size	Size of external flash connected to ports of QSPI0B and quadSPI0B_CS1, in bytes
			sflash_B2_size field must be set to 0 if the serial flash device is not present.
0x44 - 0x47	4	sclk_freq	Frequency of QuadSPI serial clock 1
			0 Low frequency
			1 Mid frequency
			2 High frequency
			See the MCU bootloader chapter in the chip reference manual for the definitions of low-frequency, mid-frequency, and high-frequency. In MK82F256, they are 24 MHz, 48 MHz, and 96 MHz.
0x48 – 0x4b	4	busy_bit_offset	Busy bit offset in status register of Serial flash
			[31:16] Busy bit polarity, valid range is 0-1:
			0 - Busy flag in status register is 1 when flash devices are busy.
			1 - Busy flag in status register is 0 when flash devices are busy.
			[15:0]: The offset of busy flag in status register; valid range is 0 - 31.
0x4c - 0x4f	4	sflash_type	Type of serial flash
			0 Single mode
			1 Dual mode
			2 Quad mode
			3 Octal mode
0x50 - 0x53	4	sflash_port	Port enablement for QuadSPI module
			0 Only pins for QSPI0A are enabled
			1 Pins for both QSPI0A and QSPI0B are enabled
0x54 - 0x57	4	ddr_mode_enable	Enable DDR mode
			0 DDR mode is disabled

Table continues on the next page...

Table 6-4. Configuration fields in QSPI config block (continued)

Offset	Size	Configuration Field	Description
	(bytes)		
			1 DDR mode is enabled
0x58 – 0x5b	4	dqs_enable	Enable DQS
			0 DQS is disabled
			1 DQS is enabled
0x5c - 0x5f	4	parallel_mode_enable	Enable Parallel Mode
			0 Parallel mode is disabled
			1 Parallel mode is enabled ¹
0x60 - 0x63	4	portA_cs1	Enable QuadSPI0A_CS1
			0 QuadSPI0A_CS1 is disabled
			1 QuadSPI0A_CS1 is enabled
			portA_cs1 field must be set to 1 if sflash_A2_size is not equal to 0.
0x64 - 0x67	4	portB_cs1	Enable QuadSPI0B_CS1
			0 QuadSPI0B_CS1 is disabled
			1 QuadSPI0B_CS1 is enabled
			portB_cs1 field must be set to 1 if sflash_B2_size is not equal to 0.
0x68 – 0x6b	4	fsphs	Full Speed Phase selection for SDR instructions
			0 Select sampling at non-inverted clock
			1 Select sampling at inverted clock
0x6c - 0x6f	4	fsdly	Full Speed Delay selection for SDR instructions
			0 One clock cycle delay
			1 Two clock cycles delay.
0x70 - 0x73	4	ddrsmp	DDR sampling point
			Valid range: 0 - 7
0x74 - 0x173	4	look_up_table	Look-up-table for sequences of instructions
0x174 – 0x177	4	column_address_space	Column Address Space
			Defines the width of the column address
0x178 – 0x17b	4	config_cmd_en	Enable additional configuration command
			0 Additional configuration command is not needed
			1 Additional configuration command is needed
0x17c - 0x18b	16	config_cmds	IPCR arrays for each connected SPI flash
			All fields must be set to 0 if config_cmd_en is not asserted.
0x18c - 0x19b	16	config_cmds_args	Command arrays needed to be transferred to external spi flash
			All fields must be set to 0 if config_cmd_en is not asserted.

Table continues on the next page...

QuadSPI Peripheral

Table 6-4. Configuration fields in QSPI config block (continued)

Offset	Size (bytes)	Configuration Field	Description
0x19c - 0x19f	4	differential_clock_pin_ena	Enable differential flash clock pin
		ble	0 Differential flash clock pin is disabled
			1 Differential flash clock pin is enabled
0x1a0 - 0x1a3	4	flash_CK2_clock_pin_ena	Enable Flash CK2 Clock pin
		ble	0 Flash CK2 Clock pin is disabled
			1 Flash CK2 Clock pin is enabled
0x1a4 - 0x1a7	4	dqs_inverse_sel	Select clock source for internal DQS generation
			0 Use 1x internal reference clock for DQS generation
			1 Use inverse 1x internal reference clock for DQS generation
0x1a8 - 0x1ab	4	dqs_latency_enable	DQS Latency Enable
			0 DQS latency disabled
			1 DQS feature with latency included enabled
0x1ac - 0x1af	4	dqs_loopback_internal	DQS loopback from internal DQS signal or DQS Pad
			0 DQS loopback is sent to DQS pad first and then looped back to QuadSPI
			1 DQS loopback from internal DQS signal directly
0x1b0 - 0x1b3	4	dqs_phase_sel	Select Phase Shift for internal DQS generation
			0 No Phase shift
			1 Select 45° phase shift
			2 Select 90° phase shift
			3 Select 135° phase shift
0x1b4 - 0x1b7	4	dqs_fa_delay_chain_sel	Delay chain tap number selection for QuadSPI0A DQS
			Valid range: 0 - 63
0x1b8 - 0x1bb	4	dqs_fb_delay_chain_sel	Delay chain tap number selection for QuadSPI0B DQS
			Valid range: 0 - 63
0x1bc - 0x1c3	8	-	Reserved
0x1c4 - 0x1c7	4	page_size	Page size of external SPI flash. ¹
			Page size of all SPI flash devices must be the same
0x1c8 - 0x1cb	4	sector_size	Sector size of external SPI flash. ¹
			Sector size of all SPI flash devices must be the same.
0x1cc - 0x1cf	4	timeout_milliseconds	Timeout in terms of milliseconds.
			0 Timeout check is disabled.
			NOTE: If the time that the external SPI device is busy is more than this timeout value, then the QuadSPI driver returns a timeout.
0x1d0 - 0x1d3	4	ips_cmd_second_divider	Second divider for IPs command based on QSPI_MCR[SCLKCFG]; the maximum value of

Table continues on the next page...

Table 6-4. Configuration fields in QSPI config block (continued)

Offset	Size (bytes)	Configuration Field	Description
			QSPI_MCR[SCLKCFG] depends on the specific device.
0x1d4 - 0x1d7	4	need_multi_phase	0 Only 1 phase is necessary to access external flash devices
			Multiple phases are necessary to erase/program external flash devices
0x1d8 - 0x1db	4	is_spansion_hyperflash	0 External flash devices is not in the Cypress HyperFlash family
			1 External flash devices is in the Cypress HyperFlash family
0x1dc - 0x1df	4	pre_read_status_cmd_add ress_offset ²	Additional address for the PreReadStatus command. Set this field to 0xFFFF FFFF if it is not required.
0x1e0 - 0x1e3	4	pre_unlock_cmd_address _offset ²	Additional address for PreWriteEnable command. Set this field to 0xFFFF FFFF if it is not required.
0x1e4 - 0x1e7	4	unlock_cmd_address_offs et ²	Additional address for WriteEnable command. Set this field to 0xFFFF FFFF if it is not required.
0x1e8 - 0x1eb	4	pre_program_cmd_addres s_offset ²	Additional address for PrePageProgram command. Set this field to 0xFFFF FFFF if it is not required.
0x1ec - 0x1ef	4	pre_erase_cmd_address_ offset ²	Additional address for PreErase command. Set this field to 0xFFFF FFFF if it is not required.
0x1f0 - 0x1f3	4	erase_all_cmd_address_o ffset ²	Additional address for EraseAll command. Set this field to 0xFFFF FFFF if it is not required.
0x1f4 - 0x1ff	12	-	Reserved

- 1. If parallel mode is enabled, then page size and sector size must be twice the actual size.
- 2. These fields are effective only if "need_multi_phase" field is set to 1.

It is recommended to configure QSPI to SDR mode with one QCB during the program and switch to DDR mode with another QCB after the program completes, where it is possible to achieve higher program performance with the MCU bootloader.

6.8.2 Look-up-table

The look-up table (LUT) is a part of the QCB, and contains sequences for instructions, such as read and write instructions. The MCU bootloader defines LUT entries to support erase, program, and read operations.

The sequence in each LUT entry is target-specific. See the datasheet or reference manual of the corresponding serial flash device.

Table 6-5. Look-up table entries for bootloader

Index	Field	Description
0	Read	Sequence for read instructions
1	WriteEnable	Sequence for WriteEnable instructions
2	EraseAll	Sequence for EraseAll instructions
3	ReadStatus	Sequence for ReadStatus instructions
4	PageProgram	Sequence for Page Program instructions
6	PreErase ¹	Sequence for Pre-Erase instructions
7	SectorErase	Sequence for Sector Erase
8	Dummy	Sequence for dummy operation if needed.
		For example, if continuous read is configured in index 0, then the dummy LUT should be configured to force the external SPI flash to exit continuous read mode.
		If a dummy operation is not required, then this LUT entry must be set to 0.
9	PreWriteEnable ¹	Sequence for Pre-WriteEnable instructions
10	PrePageProgram ¹	Sequence for Pre-PageProgram instructions
11	PreReadStatus ¹	Sequence for Pre-ReadStatus instructions
5, 12, 13, 14, 15	Undefined ¹	All of these sequences are free to be used for other purpose. For example, index 5 can be used for enabling Quad mode of SPI flash devices, see Section 3.3.2 for more details.

1. If these LUT entries are are not required, then they are allowed to be used for other purposes.

NOTE

For most types of SPI flash devices available in the market, only index 0, 1, 3, 4, 7, and 8 are required. However, for other types of high-end SPI flash devices, i.e., Cypress HyperFlash, additional indexes listed above may be required.

Configure QuadSPI module 6.8.3

The MCU bootloader is able to access external SPI devices via the QuadSPI module, but only after the QuadSPI module is configured. There are 2 ways to configure the QuadSPI module:

- Configure QuadSPI module at runtime
- Configure QuadSPI module at start-up

Table 6-6. Configuring the QuadSPI module

Configure QuadSPI at	Procedure	Clock updates during QuadSPI module configuration
runtime	 Use a WriteMemory command to program the QCB to either a region of RAM or internal flash. Use the ConfigQuadSPI command to configure the QuadSPI module with the QCB that was programmed before. After the above operations, the QuadSPI module has been set to an expected mode specified by the QCB, so the MCU bootloader is now able to access all connected SPI flash devices. 	If QuadSPI module is configured at runtime: The System Core clock will not be updated if the QuadSPI module is configured at runtime; only QUADSPI_MCR [SCLKCFG] is updated according to sclk_freq field within the QCB. In this case, the clock source for QuadSPI module is MCGFLL (QUADSPIO_SOCCR [QSPISRC] equals 1).
start-up	The steps of configuring QuadSPI at startup is based on the runtime procedure, if the QCB is not present at address 0 of the 1st external SPI flash device. 1. Configure the QuadSPI module at runtime (procedure above). 2. Erase the 1st sector of the 1st connected external SPI flash device using the FlashEraseRegion command. 3. Program the QCB to address 0 of the 1st connected external SPI flash device using the WriteMemory command. NOTE: For some types of SPI flash devices (like Cypress HyperFlash) which do not support basic reads (0x03) with 24-bit addresses, an alternative is available: for this step, program the QCB to internal flash, set the "qspiConfigBlockPointer" in the BCA to the start address of QCB, and program the BCA to 0x3c0. 4. Update BOOTSRC_SEL field (bits [7:6]) in FOPTregister at the address 0x40D to "0b'10", which means "boot from ROM with QuadSPI configured". 5. Reset the target. 6. After start-up, ROM code reads the QCB from address 0 of the external SPI flash and then configures the QuadSPI according to the QCB. 7. Now, the MCU bootloader is able to access all connected SPI flash devices. The QuadSPI module will be configured automatically out of reset, if the QCB is already present and the BOOTSRC_SEL field (bits [7:6]) in FOPTregister at the address 0x40D equals	If QuadSPI module is configured at start-up: The System Core clock will be updated to 72/96 MHz, if the QuadSPI module is configured at start-up. In this case, the clock source of the QuadSPI module switches to MCGFLL. The corresponding registers are updated with the values listed in the table Register value updates when the QuadSPI module is configured at start-up. NOTE: For K80/1/2, the core clock is updated to 96 MHz. For KL81/2, the core clock is updated to 72 MHz.

The user application boot from QuadSPI in XIP mode should not change the QuadSPI source clock from what ROM has configured (as shown in the previous table); otherwise a hard fault may occur. However, the QuadSPI source clocks (listed in

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the next table) can be changed successfully, if the application avoids shutting down the QSPI clock during clock switching; for example, if the clock switch-related codes are relocated in either internal flash or SRAM.

6.8.4 Access external SPI flash devices using QuadSPI module

The MCU bootloader supports access to external SPI flash devices using the following commands:

- Flash-erase-all: This command can erase all SPI flash devices defined in the QCB. For example, if "flash-erase-all 1", the 1 represents the source of the erasure command is QuadSPI memory.
- Flash-erase-region: This command can erase a specified range of flash within connected SPI flash devices. For example "flash-erase-region 0x68000000 0x10000".
- Write-memory: The MCU bootloader calls the Write-memory command to program specified data to a given region of connected SPI flash devices. For example, "writememory 0x68001000 led_demo.bin".
- **Read-memory:** The MCU bootloader calls the Read-memory command to read data from a given region of connected SPI flash devices. For example, "read-memory 0x68000000 1024 temp.bin".

These commands return error codes.

Table 6-7. Status Error Codes for accessing QuadSPI memory

Error Code	Value	Description
kStatus_Success	0	Operation succeeded without error
kStatus_QspiFlashSizeError	400	Size of external SPI flash is invalid
kStatus_QspiFlashAlignmentError	401	Start Address for program is not page-aligned
kStatus_QspiFlashAddressError	402	The address is invalid
kStatus_QspiFlashCommandFailure	403	The operation failed
kStatus_QspiNotConfigured	405	QSPI module is not successfully configured
kStatus_QspiFlashUnkownProperty	404	Unknown QSPI property
kStatus_QspiCommandNotSupported	406	The command is not supported under certain modes
kStatus_QspiCommandTimeout	407	The time that the external SPI device is busy more than the timeout value (timeout_milliseconds).
kStatus_QspiWriteFailure	408	QSPI module cannot perform a program command at the current clock frequency
kStatus_QspiModuleBusy	409	QSPI module is busy, or caused by incorrect configuation of QCB

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6.8.5 Boot directly from QuadSPI

The MCU bootloader supports booting directly from QuadSPI. To boot directly from QuadSPI, the following conditions must be met:

- The bootFlags field in BCA is set to 0xFE, which means "boot directly from OuadSPI".
- The BOOTSRC_SEL field (bits [7:6]) in the FOPT register at address 0x40D is set to "0'b10", which means "boot from ROM with QuadSPI configured".
- User application is valid.
- QuadSPI configuration block (QCB) is valid
- CRC check passed if the CRC check feature is enabled.

6.8.6 Example QCB

Here is an example QCB for the MX25U3235F device on TWR-K80F150M, FRDM-K82F, TWR-KL82Z72M, and FRDM-KL82Z. See the *MCU Bootloader QuadSPI User's Guide* (document MBOOTQSPIUG) for more details.

```
const qspi_config_t qspi_config_block =
     .tag = kQspiConfigTag,
                                                     // Fixed value, do not change
     .version = {.version = kQspiVersionTag}, // Fixed value, do not change
    .lengthInBytes = 512,
                                                    //Fixed value, do not change
    .sflash_A1_size = 0x400000,
                                                // 4MB
     .sclk_freq = kQspiSerialClockFreq_High, // High frequency, in K82-256, it means
96MHz/1 = 96MHz
    .busy bit offset = 0,
                                                    // Busy offset is 0
    .ddr mode enable = 0,
                                                // disable DDR mode
    .dqsenable = 0,
                                                    // Disable DQS feature
    .parallel mode enable = 0,
                                               // QuadSPI module work under serial mode
     .pagesize = 256,
                                                    // Page Size : 256 bytes
    .sectorsize = 0x1000,
                                                  // Sector Size: 4KB
    .device mode config en = 1,
                                            // Enable quad mode for SPI flash
    .device cmd = 0x40,
                                                // Enable quad mode via set bit 6 in
status register to 1
    .write cmd ipcr = 0 \times 050000000U,
                                         // IPCR indicating seg id for Quad Mode Enable
     .ips command second divider = 3,
                                        //Set second divider for QSPI serial clock to 3
     .look_up_table =
          // Seq0 : Quad Read (maximum supported freq: 104MHz)
          CMD:
                     0xEB - Quad Read, Single pad
          ADDR:
                     0x18 - 24bit address, Quad pads
                     0x06 - 6 clock cycles, Quad pads
          DUMMY:
          READ:
                     0x80 - Read 128 bytes, Quad pads
          JUMP_ON_CS: 0
          [0] = 0x0A1804EB, [1] = 0x1E800E06, [2] = 0x2400,
          // Seg1: Write Enable (maximum supported freg: 104MHz)
          CMD:
                    0x06 - Write Enable, Single pad
```

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```
[4] = 0x406,
      // Seq2: Erase All (maximum supported freq: 104MHz)
      CMD:
              0x60 - Erase All chip, Single pad
      [8] = 0x460,
      //Seg3: Read Status (maximum supported freg: 104MHz)
             0x05 - Read Status, single pad
     READ:
           0x01 - Read 1 byte
     [12] = 0x1c010405,
      // Seq4: 4 I/O Page Program (maximum supported freq: 104MHz)
             0x38 - 4 I/O Page Program, Single pad
             0x18 - 24bit address, Quad pad
      ADDR:
      WRITE: 0x40 - Write 64 bytes at one pass, Quad pad
      [16] = 0x0A180438, [17] = 0x2240,
      // Seq5: Write status register to enable quad mode
      CMD:
             0x01 - Write Status Register, single pad
      WRITE: 0x01 - Write 1 byte of data, single pad
      [20] = 0x20010401,
      // Seq7: Erase Sector
      CMD: 0x20 - Sector Erase, single pad
      ADDR: 0x18 - 24 bit address, single pad
     [28] = 0x08180420,
     // Seq8: Dummy
     /*
            0 - Dummy command, used to force SPI flash to exit continuous read mode.
     unnecessary here because the continuous read mode is not enabled.
     [32] = 0,
},
```

6.9 LIN (over LPUART) Peripheral

The MCU bootloader supports loading data into flash via LIN protocol. LIN protocol is a 1-wire serial protocol and uses the UART format to send data. However, LIN protocol is a master-slave communication. The master is the only one that controls and initiates all communication.

Transfers to LIN are supported at several speeds:

- 19200 Hz (the default transfer rate)
- 9600 Hz
- 4800 Hz

Packet transfer:

Based on the configuration speed, MCU bootloader communications will take place over the LPUART peripheral. The following flow charts show:

- How the host detects an ACK from the target
- How the host detects a ping response from the target
- How the host detects a command response from the target

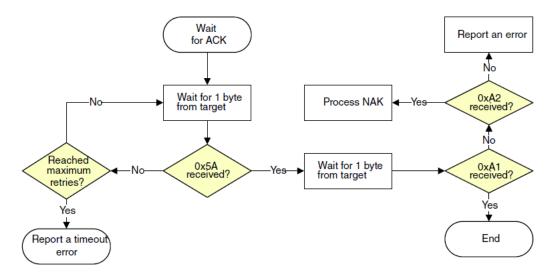


Figure 6-19. Host reads an ACK from target via LPUART

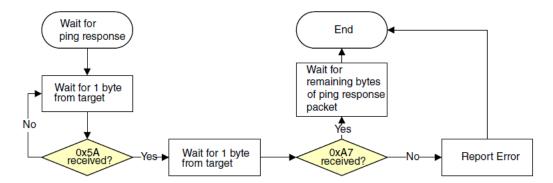


Figure 6-20. Host reads a ping response from target via LPUART

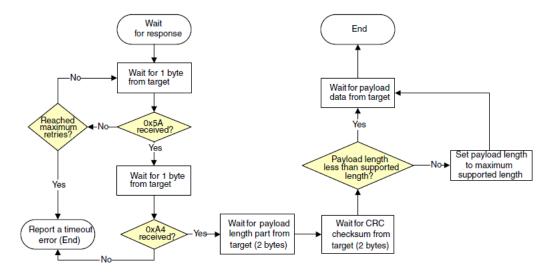


Figure 6-21. Host reads a command response from target via LPUART

Since LIN is a master-slave communication protocol. Every communication is initiated by the master and can be answered by one or multiple slaves. However, slaves cannot communicate information until master has requested them to do it. LIN groups all data to communicate in different frames. Each frame may be linked to one or multiple slaves. Every frame is divided in two parts. The header command and the response. The header command is always send by the master and contains the command ID of that frame. The response field contains the data, it can be either send by the master node or the slave node.

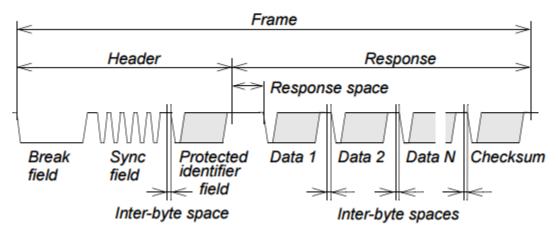


Figure 6-22. Frame structure

MCU bootloader is always working in slave node mode, it can only wait for the master (LIN host) to send the frame request header. Once received the request, it will take the action based on LIN frame configuration table.

6.9.1 LIN Configuration

In the LIN protocol communication, there are two node type, Master and Slave. Master node will be in charge of sending out header command request. Both master and slave nodes will receive and handle this command request. Each node has a pre-defined frame configuration table. This table will define the command ID, frame size and attributes of the frame for each command. Each node will translate the command based on this table. There is one field in each command to define the node role for this command – either publisher or subscriber. Publisher means this command request the node to send out a frame. Subscriber means this command request the node to receive a frame.

Here is the LIN master and slave (MCU bootloader) LIN frame configuration definitions:

Frame table structure

```
typedef struct
{
    lin_frame_type frm_type;
    uint8_t frm_len;
    lin_frame_response frm_response;
    uint8_t frm_offset;
    uint8_t flag_offset;
    uint8_t flag_size;
    uint32_t delay;
    const uint8_t *frame_data_ptr;
} lin_frame_struct;
```

Master Frame Table (resides in host)

Slave Frame Table (resides in flashloader)

Frame ID definition table

Currently we only use ID 0x30 and x33 in our MCU bootloader implementation.

```
static uint8_t LI0_lin_configuration_RAM[LI0_LIN_SIZE_OF_CFG] = {0x00, 0x30, 0x33, 0x36,
0x2D, 0x3C, 0x3D, 0xFF};
```

LIN (over LPUART) Peripheral

Chapter 7 Peripheral interfaces

7.1 Introduction

The block diagram shows connections between components in the architecture of the peripheral interface.

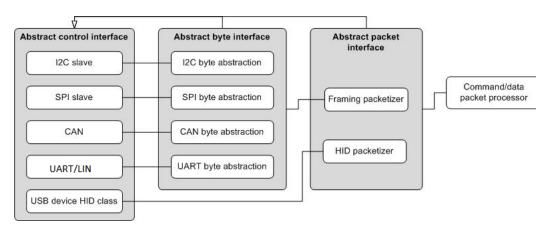


Figure 7-1. Components peripheral interface



Figure 7-2. USB/MSC Peripheral interface

In this diagram, the byte and packet interfaces are shown to inherit from the control interface.

Abstract control interface

All peripheral drivers implement an abstract interface built on top of the driver's internal interface. The outermost abstract interface is a packet-level interface. It returns the payload of packets to the caller. Drivers that use framing packets have another abstract interface layer that operates at the byte level. The abstract interfaces allow the higher layers to use exactly the same code regardless which peripheral is being used.

The abstract packet interface feeds into the command and data packet processor. This component interprets the packets returned by the lower layer as command or data packets.

7.2 Abstract control interface

This control interface provides a common method to initialize and shutdown peripheral drivers. It also provides the means to perform the active peripheral detection. No data transfer functionality is provided by this interface. That is handled by the interfaces that inherit the control interface.

The main reason this interface is separate from the byte and packet interfaces is to show the commonality between the two. It also allows the driver to provide a single control interface structure definition that can be easily shared.

```
struct PeripheralDescriptor {
    //! @brief Bit mask identifying the peripheral type.
    //! See # peripheral types for a list of valid bits.
   uint32_t typeMask;
    //! @brief The instance number of the peripheral.
   uint32 t instance;
    //! @brief Configure pinmux setting for the peripheral.
    void (*pinmuxConfig)(uint32 t instance, pinmux type t pinmux);
    //! @brief Control interface for the peripheral.
    const peripheral control interface t * controlInterface;
    //! @brief Byte-level interface for the peripheral.
    //!
    //! May be NULL because not all periperhals support this interface.
    const peripheral_byte_inteface_t * byteInterface;
    //! @brief Packet level interface for the peripheral.
    const peripheral packet interface t * packetInterface;
};
struct PeripheralControlInterface
   bool (*pollForActivity)(const PeripheralDescriptor * self);
   status_t (*init)(const PeripheralDescriptor * self, BoatloaderInitInfo * info);
   void (*shutdown) (const PeripheralDescriptor * self);
```

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```
void (*pump)(const peripheral_descriptor_t *self);
}
```

Table 7-1. Abstract control interface

Interface	Description
pollForActivity()	Check whether communications has started.
init()	Fully initialize the driver.
shutdown()	Shutdown the fully initialized driver.
pump	Provide execution time to driver.

7.3 Abstract byte interface

This interface gives the framing packetizer a common interface for the peripherals that use framing packets (see framing packetizer).

The abstract byte interface inherits the abstract control interface.

```
struct PeripheralByteInterface
{
    status_t (*init)(const peripheral_descriptor_t * self);
    status_t (*write)(const peripheral_descriptor_t * self, const uint8_t *buffer, uint32_t byteCount);
};
```

Table 7-2. Abstract byte interface

Interface	Description
init()	Initialize the interface
write()	Write the requested number of bytes

NOTE

The byte interface has no read() member. Interface reads are performed in an interrupt handler at the packet level.

7.4 Abstract packet interface

The abstract packet interface inherits the abstract control interface.

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Framing packetizer

Table 7-3. Abstract packet interface

Interface	Description
init()	Initialize the peripheral.
readPacket()	Read a full packet from the peripheral.
writePacket()	Send a complete packet to the peripheral.
abortDataPhase()	Abort receiving of data packets.
finalize()	Shut down the peripheral when done with use.
getMaxPacketSize	Returns the current maximum packet size.
byteReceivedCallback	Notification of received byte.

7.5 Framing packetizer

The framing packetizer processes framing packets received via the byte interface with which it communicates. The framing packetizer builds and validates a framing packet as it reads bytes. The framing packetizer also constructs outgoing framing packets as needed to add flow control information and command or data packets. The framing packetizer also supports data phase abort.

7.6 USB HID packetizer

The USB HID packetizer implements the abstract packet interface for USB HID, taking advantage of the USB's inherent flow control and error detection capabilities. The USB HID packetizer provides a link layer that supports variable length packets and data phase abort.

7.7 USB HID packetizer

The USB HID packetizer implements the abstract packet interface for USB HID, taking advantage of the USB's inherent flow control and error detection capabilities.

The image shows the USB MSC command/data/status flow chart.

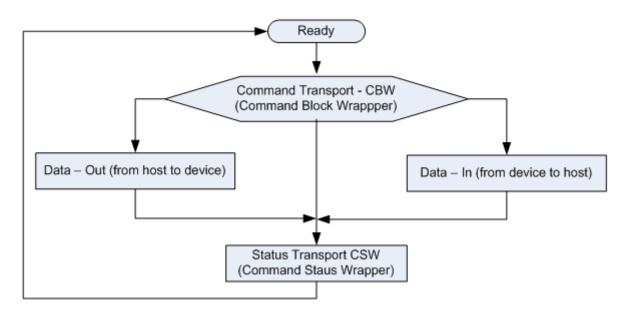


Figure 7-3. USB MSC status flow chart

- The CBW begins on a packet boundary, and ends as a short packet. Exactly 31 bytes are transferred.
- The CSW begins on a packet boundary, and ends as a short packet. Exactly 13 bytes are transferred.
- The data packet begins on a packet boundary, and ends as a short packet. Exactly 64 bytes are transferred.

7.8 Command/data processor

This component reads complete packets from the abstract packet interface, and interprets them as either command packets or data packets. The actual handling of each command is done by command handlers called by the command processor. The command handler tells the command processor whether a data phase is expected and how much data it is expected to receive.

The command/data processor ignores any unexpected commands or data packets if received. In this instance, the communications link resynchronizes upon reception of the next valid command.

Command/data processor

Chapter 8 Memory interface

8.1 Abstract interface

The bootloader uses a common, abstract interface to implement the memory read/write/fill commands. This is to keep the command layer from having to know the details of the memory map and special routines.

This shared memory interface structure is used for both the high-level abstract interface, as well as low-level entries in the memory map.

```
struct MemoryInterface
{
    status_t (*init)(void);
    status_t (*read)(uint32_t address, uint32_t length, uint8_t * buffer);
    status_t (*write)(uint32_t address, uint32_t length, const uint8_t * buffer);
    status_t (*fill)(uint32_t address, uint32_t length, uint32_t pattern);
    status_t (*flush)(void);
    status_t (*erase)(uint32_t address, uint32_t length)
}
```

The global bootloader context contains a pointer to the high-level abstract memory interface, which is one of the MemoryInterface structures. The internal implementation of this abstract interface uses a memory map table, referenced from the global bootloader context that describes the various regions of memory that are accessible and provides region-specific operations.

The high-level functions are implemented to iterate over the memory map entries until it finds the entry for the specified address range. Read and write operations are not permitted to cross region boundaries, and an error is returned if such an attempt is made.

The BootloaderContext::memoryMap member is set to an array of these structures:

```
struct MemoryMapEntry
{
    uint32_t startAddress;
    uint32_t endAddress;
    bool isExecutable;
    const MemoryInterface * interface;
};
```

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Flash driver interface

This array must be terminated with an entry with all fields set to zero.

The same MemoryInterface structure is also used to hold the memory-type-specific operations.

Note that the MemoryMapEntry::endAddress field must be set to the address of the last byte of the region, because a <= comparison is used.

During bootloader startup, the memory map is copied into RAM and modified to match the actual sizes of flash and RAM on the chip.

8.2 Flash driver interface

The flash driver uses the common memory interface to simplify the interaction with flash. It takes care of high level features such as read back verification, flash protection awareness, and so on. The flash memory functions map to the interface functions as so:

```
const memory_region_interface_t g_flashMemoryInterface =
{
    .read = &flash_mem_read,
    .write = &flash_mem_write,
    .fill = &flash_mem_fill,
    .flush = NULL,
    .erase = flash_mem_erase
};
```

Bootloader startup code is responsible for initializing the flash memory.

API	Description
flash_mem_read()	Performs a normal memory read if the specified region isn't protected from reading.
flash_mem_write()	Calls the low-level flash_program() API. Also performs program verification if enabled with the Set Property command.
flash_mem_fill()	Performs intelligent fill operations on flash memory ranges. If the fill patterns are all 1's, special action is taken. If the range is a whole number of sectors, then those sectors are erased rather than filled. Any part of an all-1's fill that is not sectoraligned and -sized is ignored (the assumption being that it has been erased to 1's already). Fills for patterns other than all 1's call into flash_program().
flash_mem_erase()	Calls the low-level flash_erase() API. Also performs erasure verification if enabled with the Set Property command (Enabled by default).

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All flash_mem_read(), flash_mem_write(), flash_mem_fill(), and flash_mem_erase() check the flash protection status for the sectors being read or programmed or erased and return an appropriate error if the operation is not allowed.

8.3 Low-level flash driver

The low-level flash driver (LLFD) handles erase and write operations on a word basis. It cannot perform writes of less than a full word.

The bootloader startup code is responsible for initializing and shutting down the LLFD.

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Low-level flash driver

Chapter 9 MCU bootloader porting

9.1 Introduction

This chapter discusses the steps required to port an existing MCU bootloader to a new device. Each step of the porting process is discussed in detail in the following sections.

9.2 Choosing a starting point

The first step is to download the latest bootloader release. Updates for the bootloader are released multiple times per year, so having the latest package is important for finding the best starting point for your port. To find the most recent bootloader release, click on mcuxpresso.nxp.com, select middleware mcu-boot when configuring the sdk package. MCU Bootloader projects can be found in <sdk_package>/boards/<box/>bootloader_examples.

The easiest way to port the bootloader is to choose a supported target that is the closest match to the desired target device.

NOTE

Just because a supported device has a similar part number to the desired target device, it may not necessarily be the best starting point. To determine the best match, refer to the data sheet and reference manual for all of the supported MCU devices.

9.3 Preliminary porting tasks

Preliminary porting tasks

All references to paths in the rest of this chapter are relative to the root of the extracted SDK package. MCU Bootloader is a middleware in SDK package loacted at middleware/ mcu-boot. Before modifying source code, the following tasks should be performed.

9.3.1 Download MCUXpresso SDK

Porting the MCU bootloader to a new target is a manual process that requires updating the device header files. This process is time-consuming and error-prone, so NXP provides Software Development Kit (SDK) for ARM Cortex-M Core devices. SDK package contains device header files and drivers. These SDK packages can be downloaded from mcuxpresso.nxp.com.

NOTE

Do not proceed with a port if a package does not yet exist for the desired target device.

In the downloaded package, header files including <device>.h, <device>_features.h, fsl_device_registers, system_<device>.h can be found in devices/<device>, and drivers can be found in devices/<device>/drivers. Add these two folders to include directories of the target device's bootloader project or add these header files and drivers to the target device's bootloader project.

9.3.2 Copy the closest match

Copy the folder of the device that most closely matches the target device in the / middleware/mcu-boot/targets folder of the bootloader source tree. Rename the folder to match the target device part number.

After the files are copied, browse the newly created folder. Rename all files that have reference to the device from which they were copied. Rename the following files:

- clock_config_<old_device>.c —> clock_config_<new_device>.c
- hardware_init_<old_device>.c —> hardware_init _<new_device>.c
- memory_map_<old_device>.c —> memory_map _<new_device>.c
- peripherals_<old_device>.c —> peripherals _<new_device>.c

Copy the following files from their location in devices/<device>/<tool chain> to the new middleware/mcu-boot/targets/<device>/src/startup folder:

• <tool chain>/startup_<device>.s

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9.3.3 Provide device startup file (vector table)

A device-specific startup file is a key piece to the port. The bootloader may not function correctly without the correct vector table. A startup file from the closest match device can be used as a reference, but it is strongly recommended that the file be thoroughly checked before using it to port due to differences in interrupt vector mappings between devices.

Create the startup file and place into the middleware/mcu-boot/targets/<device>/src/startup/ <tool chain> folder. Startup files are often assembly (*.s) and are named startup_<device>.s.

NOTE

For Kinetis devices, the 16-byte Flash Configuration Field should be carefully set in the bootloader image. The Flash Configuration Field is placed at the offset 0x400 in the bootloader image. The field is documented in the SOC reference manual under the subsection called, "Flash Configuration Field" in the "Flash Memory Module" chapter. To change the default 16-byte value for the field in the template startup_<device>.s file of the bootloader project, follow these steps:

- 1. Open the startup_<device>.s file in a text editor.
- 2. Locate the symbol where Flash Configuration Field is specified. The symbol name is "__FlashConfig" The 16-byte Flash Configuration Field data is enclosed with __FlashConfig and __FlashConfig_End symbols in the startup_<device>.s file
- 3. Change the 16-byte setting to the correct value. For example set the flash security byte, enable or disable backdoor access key, specify the 8-byte backdoor key, and so on.
- 4. Once the field is updated, save the startup_<device>.s file and close the text editor.

9.3.4 Clean up the IAR project

This example uses the IAR tool chain for the new project. Other supported tool chains can be used in a similar manner.

Preliminary porting tasks

MCU Bootloader projects can be found in <boards>/board/bootloader_examples. Open a bootloader project of the most similar device. This image shows an example of what a workspace looks like and the files that need to be touched.

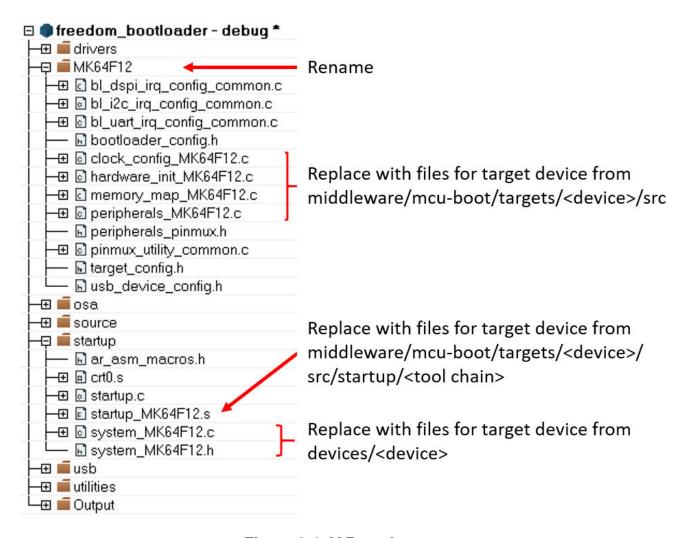


Figure 9-1. IAR workspace

Once changes have been made, update the project to reference the target device. This can be found in the project options.

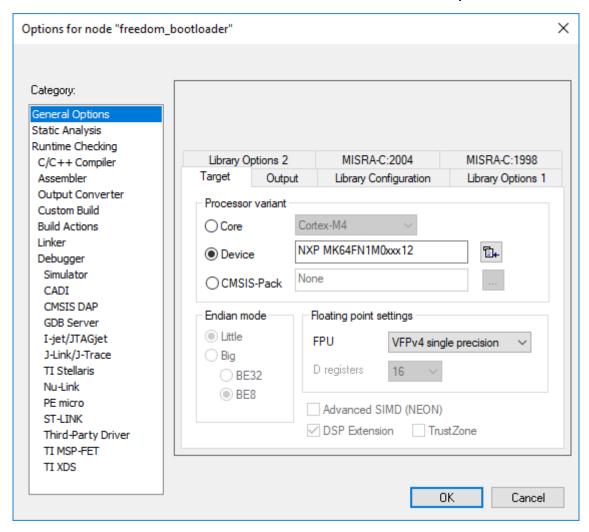


Figure 9-2. Project options

9.3.5 **Bootloader peripherals**

The bootloader source uses a C/C++ preprocessor define to configure the bootloader based on the target device. Update this define to reference the correct set of devicespecific header files.

Preliminary porting tasks

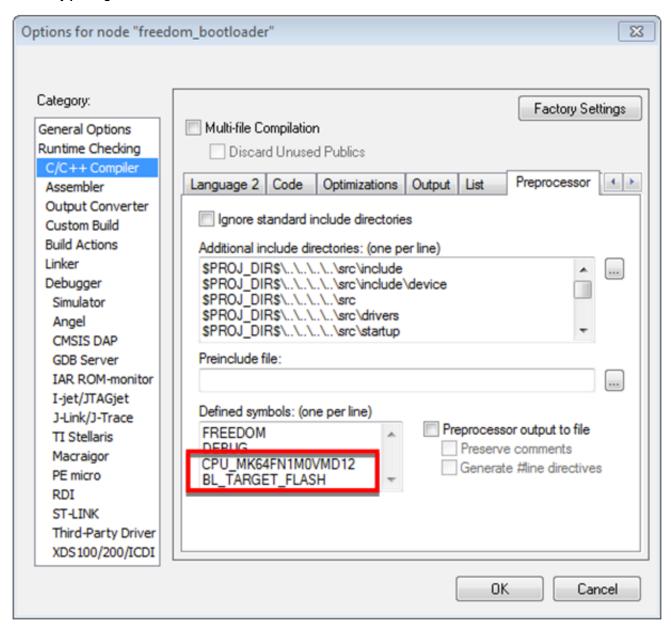


Figure 9-3. Options for node "freedom_bootloader"

If the memory configuration of the target device differs from the closest match, the linker file must be replaced. Refer to linker files in devices/<device>/<tool chain> and update it as per the bootloader project. Update the linker settings via the project options.

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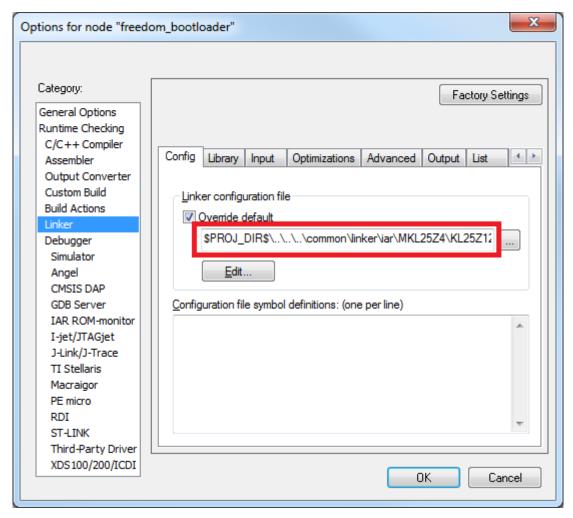


Figure 9-4. Porting guide change linker file

9.4 Primary porting tasks

After the basic file structure and source files are in place, the porting work can begin. This section describes which files need to be modified and how to modify them.

9.4.1 Bootloader peripherals

There are two steps required to enable and configure the desired peripherals on the target device:

- Choose which peripherals can be used by the bootloader.
- Configure the hardware at a low level to enable access to those peripherals.

9.4.1.1 Supported peripherals

The bootloader uses the peripherals_<device>.c file to define which peripheral interfaces are active in the bootloader. The source file includes a single table, <code>g_peripherals[]</code>, that contains active peripheral information and pointers to configuration structures. This file is found in middleware/mcu-boot/targets/<device>/src.

Only place configurations for peripherals that are present on the target device. Otherwise, the processor generates fault conditions when trying to initialize a peripheral that is not physically present.

For the content of each entry in the <code>g_peripherals[]</code> table, reuse existing entries and only modify the <code>.instance</code> member. For example, starting with the following UART0 member, make the change to UART1 by simply changing <code>.instance</code> from "0" to "1".

```
{
    .typeMask = kPeripheralType_UART,
    .instance = 0,
    .pinmuxConfig = uart_pinmux_config,
    .controlInterface = &g_scuartControlInterface;
    .byteInterface = &g_scuartByteInterfacek;
    .packetInterface = &g_framingPacketInterface;
}
```

When the table has all required entries, it must be terminated with a null { 0 } entry.

9.4.1.2 Peripheral initialization

After the peripheral configuration has been selected, the low-level initialization must be accounted for. The bootloader automatically enables the clock and configures the peripheral, so the only thing required for the port is to tell the bootloader which pins to use for each peripheral. This is handled in the peripherals_pinmux.h file in middleware/mcu-boot/targets/<device>/src. The hardware_init_<device>.c file selects the boot pin used by the bootloader, which may need to be changed for the new target device.

These files most likely require significant changes to account for the differences between devices when it comes to pin routing. Each function should be checked for correctness and modified as needed.

9.4.1.3 Clock initialization

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The MCU bootloader typically uses the device default clock configuration in order to avoid dependencies on external components and simplify use. In some situations, the default clock configuration cannot be used due to accuracy requirements of supported peripherals. On devices that have on-chip USB and CAN, the default system configuration is not suficient and the bootloader configures the device to run from the high-precision internal reference clock (IRC) if available. Otherwise, it depends on the external oscillator supply.

The bootloader uses the clock_config_<device>.c file in middleware/mcu-boot/targets/ <device>/src to override the default clock behavior. If the port's target device supports USB, this file can be used. If the port's target device does not support USB, the functions within clock_config_<device>.c can be stubbed out or set to the required port value.

9.4.2 Bootloader configuration

Configure the bootloader to match the supported features and the specific memory map for the target device. Turn features on or off by using #define statements in the bootloader_config.h file in middleware/mcu-boot/targets/<device>/src. See examples for using these macros in bl_command.c (g_commandHandlerTable[] table) in the middleware/mcu-boot/src/bootloader/src folder. All checks that reference a BL_* feature can be turned on or off. Examples of these features are BL_MIN_PROFILE, BL_HAS_MASS_ERASE, and BL_FEATURE_READ_MEMORY.

One of the most important bootloader configuration choices is where to set the start address (vector table) of the user application. This is determined by the BL_APP_VECTOR_TABLE_ADDRESS define in bootloader_config.h. Most bootloader configurations choose to place the user application at address 0xA000 because that accommodates the full-featured bootloader image. It is possible to move this start address if the resulting port reduces features (and therefore, code size) of the bootloader.

NOTE

Load the Release build of the flash-resident bootloader if you plan to place the user application at 0xA000. Loading the Debug build requires you to move the application address beyond the end of the bootloader image. This address can be determined from the bootloader map file.

9.4.3 Bootloader memory map configuration

Primary porting tasks

The MCU device memory map and flash configuration must be defined for proper operation of the bootloader. The device memory map is defined in the g_memoryMap[] structure of the memory_map_<device>.c file, which can be found in middleware/mcu-boot/targets/<device>/src. An example memory map configuration is shown.

In addition to the device memory map, the correct SRAM initialization file must be selected according to the target device. This file is split based on ARM® Cortex®-M4 and Cortex-M0+ based devices, so the likelihood of having to change it is low.

The sram_init_cm4.c file is located in middleware/mcu-boot/src/memory/src for M4 devices and sram_init_cm0plus.c for M0+ devices.

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Chapter 10 Creating a custom flash-resident bootloader

10.1 Introduction

In some situations the ROM-based or full-featured flash-resident bootloader cannot meet the requirements of a use application. Examples of such situations include special signaling requirements on IO and peripherals not supported by the bootloader, or the more basic need to have as small of a code footprint as possible (for the flash-resident bootloader). This section discusses how to customize the flash-resident bootloader for a specific use case. The IAR tool chain is used for this example. Other supported tool chains can be similarly configured.

10.2 Where to start

The MCU bootloader comes with various preconfigured projects, including configurations for a flashloader (if applicable for the device) and a flash-resident bootloader. For all of these projects, supported features can easily be enabled or disabled to suit the needs of a custom application.

The projects containing these preconfigured options are located in the <sdk_package>/boards/<box/>board>/bootloader_examples folder. Inside of this folder there are bootloader projects including flash-resident bootloader, flashloader, flashloader_loader, and demo_apps. The figure below shows the bootloader projects for FRDM-K64F board.

Flash-resident bootloader source tree

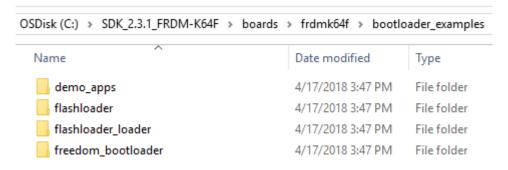


Figure 10-1. Bootloader projects

Flash-resident bootloader source tree 10.3

It is important to understand the source tree to understand where modifications are possible. Here is an example of a source tree for one of the bootloader configurations.

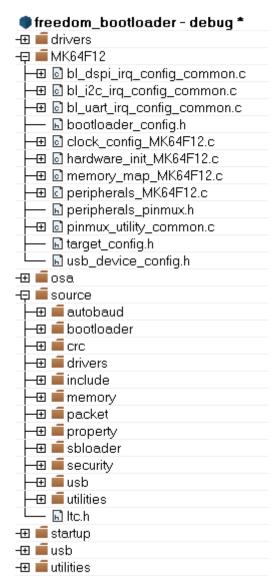


Figure 10-2. Source tree for bootloader configuration

There are two folders in each bootloader project: a device-specific folder and a "source" folder. All files in the device-specific folder are located in the <sdk package>/ middleware/mcu-boot/targets/<device>/src folder, and are specific to the target device. The "source" folder is located at the top level of the bootloader tree, and the subfolders in the project correspond to the real folder/file structure on the PC. The files in the "source" folder are the core files of the bootloader.

The bootloader source is separated in a way that creates a clear line between what a user needs to modify and what they do not. Among other things, the files in the devicespecific folder allow the application to select which peripherals are active as well as how to configure the clock, and are intended to be modified by the user. The files in the "source" folder can be modified, but should only require modification where very specific customization is needed in the bootloader.

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10.4 Modifying source files

The files that cover the majority of the customization options needed by applications are located in the device-specific folder. These files allow modification to the basic configuration elements of the bootloader application, and are not associated with the core functionality of the bootloader.

In the device-specific folder, the source files contain this information:

- **bootloader_config.h** Bootloader configuration options such as encryption, timeouts, CRC checking, the UART module number and baud rate, and most importantly, the vector table offset for the user application.
- **clock_config_<device>.c** Configures the clock for the device. This includes system, bus, etc.
- hardware init <device>.c Enables and configures peripherals used by the application. This includes pin muxing, peripheral initialization, and the pin used as a bootloader re-entry (bootstrap) mechanism.
- memory map <device>.c Contains a table that stores the memory map information for the targeted device.
- peripherals_<device>.c Contains the table used by the bootloader to check which peripheral interfaces are enabled. This is the file used to disable any unused peripheral interfaces.
- peripherals_pinmux.h Contains macros to identify peripheral pin mux, typically specific to a target platform.

10.5 Example

One of the most common customizations performed on the MCU bootloader is removing unused or unwanted peripheral interfaces. The default configuration of the bootloader enables multiple interfaces, including UART, SPI, I2C and (on some devices) USB and CAN. This example will describe how to remove the SPI0 interface from the provided bootloader projects. The same methodology can be used to select any of the supported interfaces.

Modifying a peripheral configuration macro 10.6

The bootloader_confg.h file is located in <sdk_package>/middleware/mcu-boot/targets/ <device>/src. It contains macros such as:

```
#if !defined(BL_CONFIG_SPI0)
#define BL_CONFIG_SPI0 (1)
#endif
```

To remove an interface, either modify this file to set the macro to (0), or pass the macro define to the toolchain compiler in the project settings. For example:

```
BL_CONFIG_SPI0=0
```

Setting this macro to zero removes the interface from the g_peripherals table and prevents related code from linking into the bootloader image.

10.7 How to generate MMCAU functions in binary image

1. Add the MMCAU driver to the project.

Add the MMCAU driver mmcau_aes_functions.c to the project. There are only three functions in this driver.

```
//! @brief An initialization function for the decryption peripheral
void mmcau_aes_init(uint32_t *key, uint32_t *keySchedule, uint32_t *rcon);

//! @brief Encrypts a 16 byte block of data//!
in and out may use the same address so encrypting in place is supported
void mmcau_aes_encrypt(uint32_t *in, uint32_t *key, uint32_t *keySchedule, uint32_t
*out);

//! @brief Decrypts a 16 byte block of data//!
in and out may use the same address so decrypting in place is supported
void mmcau_aes_decrypt(uint32_t *in, uint32_t *key, uint32_t *keySchedule, uint32_t
*out):
```

The following figure shows that the driver has been added to the K80F256 bootloader project

How to generate MMCAU functions in binary image

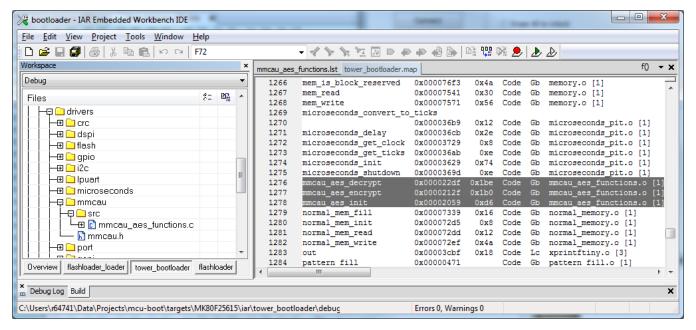


Figure 10-3. Driver added to K80F256F project

2. Change the compile optimization level to low.

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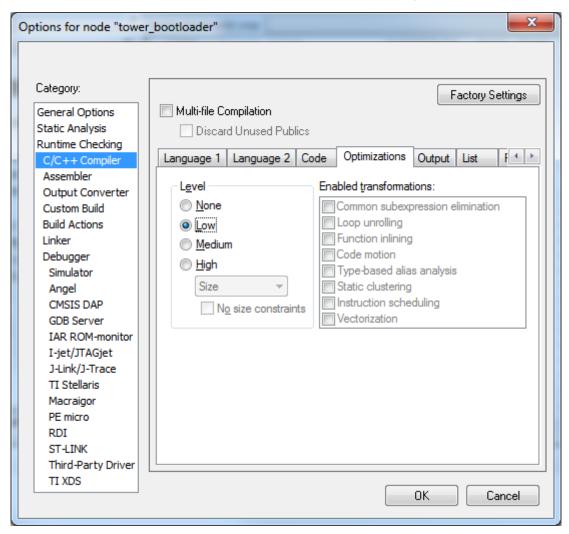


Figure 10-4. Compile optimization level

3. Compile the project and view the map file while generating the binary file for the entire project. The start address and offset of mmcau_aes_init, mmcau_aes_encrypt, and mmcau_aes_decrypt are shown.

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How to generate MMCAU functions in binary image

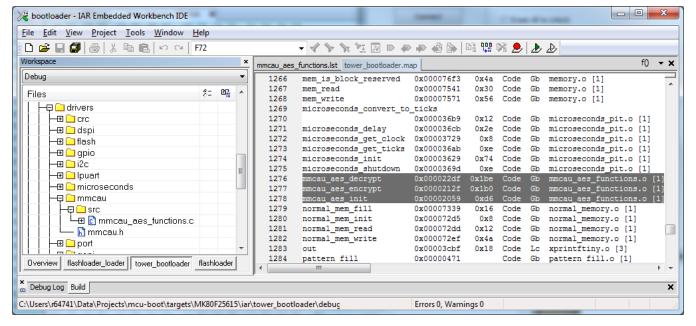


Figure 10-5. Start address MMCAU

4. Open the list file to see the MMCAU algorithm length - 1212 = 0x4BC.

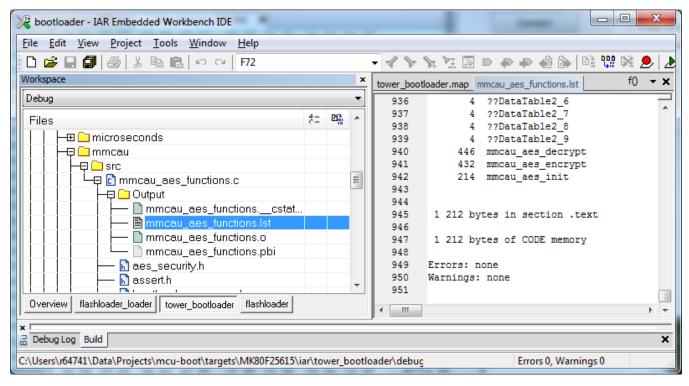


Figure 10-6. MMCAU algorithm length

5. Extract functions from the address of mmcau_aes_init (0x2058 in this case) by the MMCAU algorithm length (0x4BC) and save it. This is the MMCAU algorithm only. See mmcau function cm4.bin.

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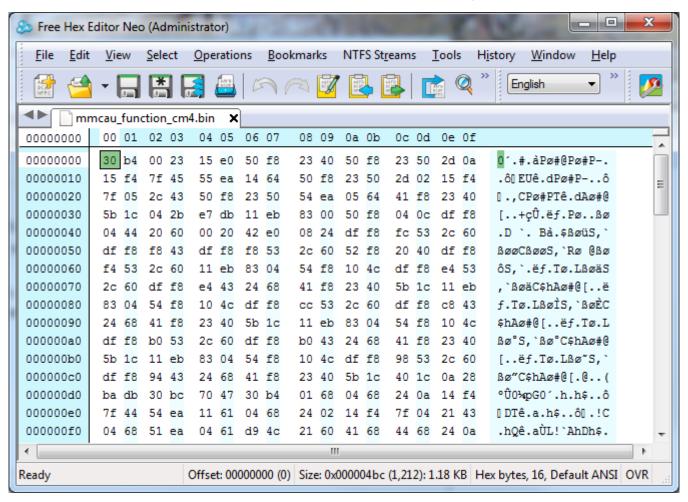


Figure 10-7. mmcau_function_cm4.bin

6. Add the MMCAU algorithm to the Bootloader Configuration Area (BCA).

The MMCAU algorithm can be loaded to any accesible memory, such as RAM or flash. However, you need to update the BCA in order to have a pointer to an MMCAu set-up structure. See aeas security.h for the structure definition.

```
uint32_t tag;
                                  // 'kcau' = 0x
    uint32_t length;
                                // number of bytes to copy, copied from the start of
aes init
    uint32 t aes init start;
    uint32_t aes_encrypt_start;
    uint32_t aes_decrypt_start;
} mmcau function info t;
```

The location offset of the MMCAU algorithm is x020. The BCA start is 0x3C0, and the mmcau function info address is 0x3E0. For decryption to work properly, the mmcau function info must contain valid values for all the fields in this structure. This structure size is 20 bytes (0x14 bytes).

Tag

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The tag field must equal 'kcau'

• Length

It is the total length of all MMCAU AES algorithms. See mmcau_aes_functions.lst. It is 1212 bytes (0x4BC).

• aes init start

Memory location of the aes_init function, the address where mmcau function cm4.bin is to be loaded. This function size is 0xD6.

• aes_encrypt_start

Memory location of the aes_encrypt function. This function size is 0x1B0.

aes_decrypt_start

Memory location of the aes decrypt function. This function size is 0x1BE.

The figure below contains information for each function.

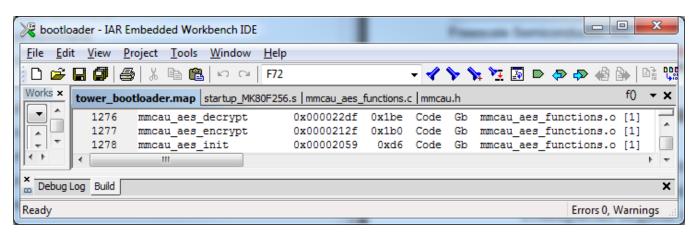


Figure 10-8. Map file

- 7. Example Add the MMCAU algorithm after the BCA.
 - BCA $0x30 \sim 0x3DF$
 - MMCAU setup in BCA 0x3E0, which shows the start of mmcau_function_info
 - Tag in mmcau_function_info $(0x410 \sim 0x413)$

The values of $0x410 \sim 0x4^3$ are 'kcau'

• Length in $mmcau_function_into (0x414 \sim 0x417)$

The value is 0x000004BC

• aes_init_start in mmcau_function_into $(0x418 \sim 0x41b)$

The value is $0x00000424 (0x410 + 0x14 (mmcau_function_info structure size))$

• aes_encrypt_start in mmcau_function_info $(0x41c \sim 0x41f)$

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The value is 0x000004fa $(0x424 + 0xd6 (mmcau_aes_init function size))$

- aes_decrypt_start in mmcau_function_info $(0x420 \sim 0x423)$
 - The value is $0x000006aa (0x4fa + 0x1b0 (mmcau_aes_encrypt function size))$
- The MMCAU algorithm starts from flash address 0x424

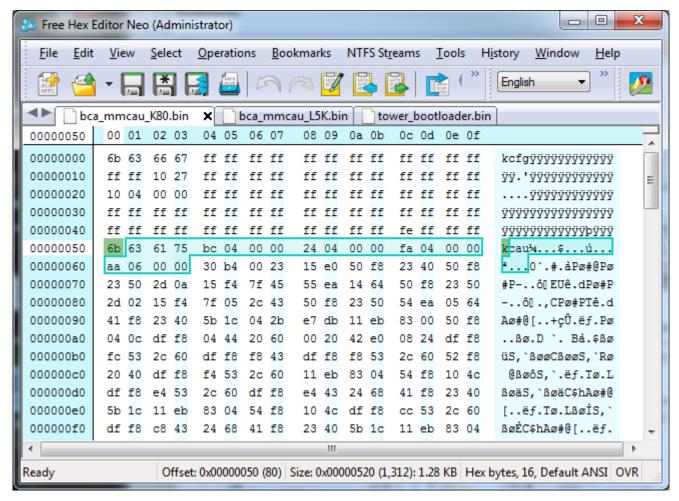


Figure 10-9. MMCAU algorithm after BCA

How to generate MMCAU functions in binary image

Chapter 11 Bootloader Reliable Update

11.1 Introduction

Reliable update is an optional but important feature of MCU bootloader. During a firmware update, an unexpected loss of power or device disconnect from the host can happen. This may result in a corrupted image or non-responsive devices. The reliable update feature is designed to solve this problem.

11.2 Functional description

The reliable update works by dividing the device memory into two regions: the main application region and backup application region. Only the backup application region is allowed to be updated by the host. Once the backup region is updated with the new firmware image, the reliable update process needs to be initiated. The MCU bootloader here checks the validity and integrity of the new application image in the backup region, and copies the new image to the main application region.

11.2.1 Bootloader workflow with reliable update

There are two methods to initiate reliable update process. The first method is to reset the device to enter the bootloader startup process, causing MCU bootloader to detect the presence of a valid image in the backup region, and kicking off the reliable update process. The second method is by issuing a reliable-update command from host using BLHOST.exe while the bootloader is running on the device.

Using the first method, the reliable update process starts before all interfaces are configured. The figure below shows the call to reliable update process during startup flow of the MCU bootloader.

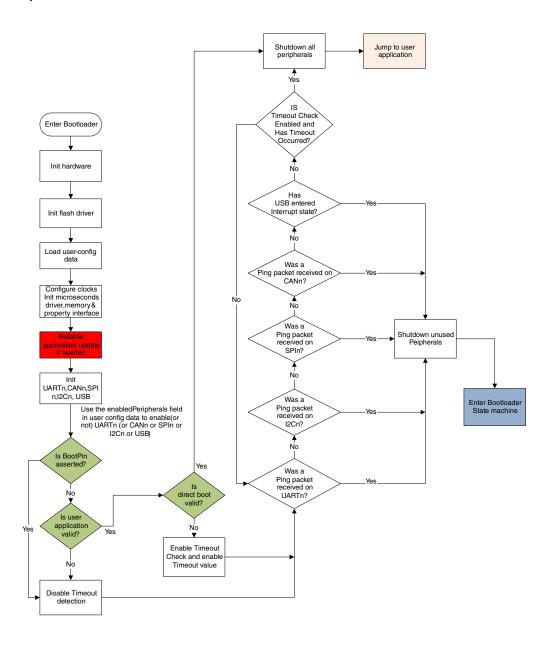


Figure 11-1. Bootloader workflow with reliable update

The second method occurs while the bootloader state machine is running. The reliable update process is triggered when the host sends the reliable update bootloader command.

11.2.2 Reliable update implementation types

There are two kinds of reliable update implementations. They can be classified as either the software version or hardware version. The main differences between software and hardware implementation are listed below:

Item	Software implementation	Hardware implementation
Applicable device	All Kinetis devices	Devices with flash swap support
Device memory distribution	Bootloader + main application + backup application	Main bootloader + main application + backup bootloader + backup application
Backup application address	Flexible	Fixed
The ability to keep two applications	No	Yes

Table 11-1. Software and hardware implementation

The most obvious difference is that the software implementation copies the backup application to the main application region, while hardware implementation swaps two half flash blocks to make the backup application become the main application. The detailed differences will be reflected in Section 12.2.3, "Reliable update flow".

See Section 12.3, "Configuration macros" on how to enable different implementations of the reliable update.

11.2.3 Reliable update flow

This chapter describes in detail both the software and hardware implementation of the reliable update process.

11.2.3.1 Software implementation

For software implementation, the backup application address is not fixed. Therefore, the application address must be specified. There are two ways for the bootloader to receive the backup application address. If the reliable update process is issued by the host, the bootloader receives the specified application address from the host itself. Otherwise, the bootloader uses the predefined application address.

After the reliable update process starts, the first thing for the bootloader is to check the backup application region . This is to determine if the reliable update feature is active by checking:

- 1. If the application pointer in the backup application is valid.
- 2. If the Bootloader Configuration Area is enabled.

Functional description

If above conditions are not met, the bootloader exits the reliable update process immediately. Else, the bootloader continues to validate the integrity of the backup application by checking: the following

- 1. Is crcStartAddress is equal to the start address of the vector table of the application.
- 2. Is crcByteCount (considered as the size of backup application) is less than or equal to the maximum allowed backup application size.
- 3. Is the calculated CRC checksum is equal to the checksum provided in backup application, given that the above conditions are met.

If the backup application is determined to be valid, the remaining process is described in the following figure.

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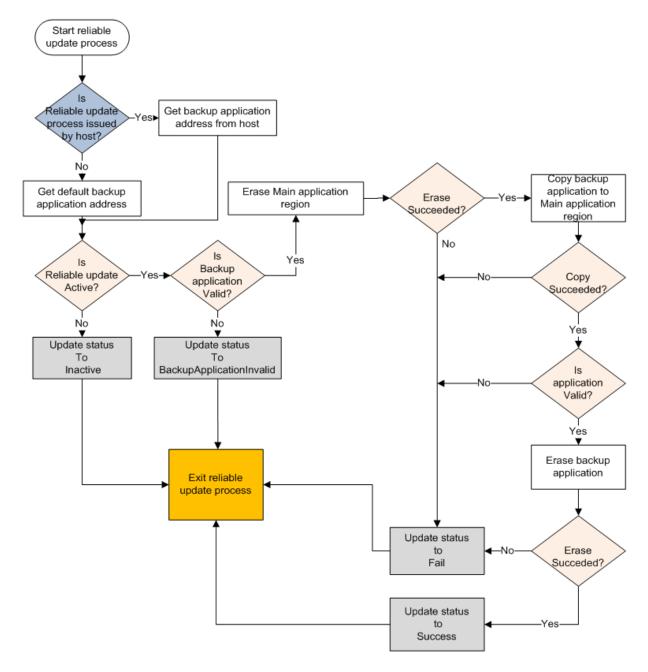


Figure 11-2. Reliable update software implementation workflow

NOTE

Not all details are shown in the above figure.

Once the main application region is updated, the bootloader must erase the backup application region before exiting the reliable update process. This prevents the bootloader to update the main application image on subsequent boots.

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11.2.3.2 Hardware implementation

For the hardware implementation, the backup application address is fixed and predefined in the bootloader, but a swap indicator address is required to swap the flash system. There are two ways for the bootloader to get the swap indicator address. If the reliable update process is issued by the host, the bootloader receives the specified swap indicator address from the host itself. Otherwise, the bootloader tries to receive the swap indicator address from the IFR, if the swap system is in the ready state.

The top level behavior of the reliable update process depends on how the bootloader gets the swap indicator address:

- If the reliable update process is issued by the host, the bootloader does the same thing as software implementation until the validity of the backup application is verified.
- If the reliable update process is from the bootloader startup sequence, the bootloader first checks the main application. If the main application is valid, then the bootloader exits the reliable update process immediately, and jumps to the main application. Otherwise, the bootloader receives the swap indicator address from IFR, then continues to validate the integrity of the backup application as the software implementation.

NOTE

It is expected that the user erases the main application region when reliable update process is intended with the next startup sequence. Otherwise, the reliable update process assumes no update is required, exits the process, and boots the image from the main application region

If the backup application is valid, see the remaining operations in the following figure.

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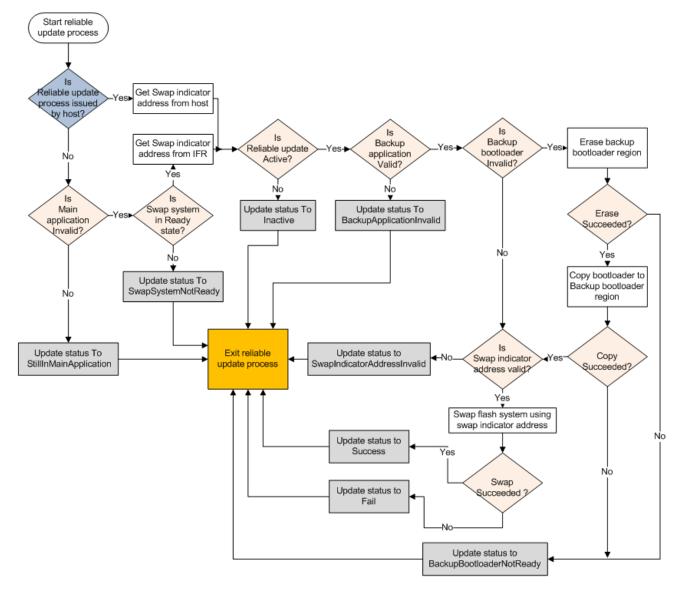


Figure 11-3. Reliable update hardware implementation workflow

NOTE

Not all details are shown in the above figure.

Once the flash system is swapped (upper flash block becomes lower flash block), the bootloader naturally treats the backup application as the main application. In the hardware implementation, after the swap, it is not necessary to erase the image from the backup region.

11.3 Configuration macros

Get property

The configuration macros defined in bootloader_config.h are used to enable the reliable update feature. For MCU bootloader v2.0.0, the feature is only enabled in the K65 Freedom and Tower flash target builds. All code added for this feature should be enabled only if the macros are defined. Currently, these macros are defined as:

- BL_FEATURE_RELIABLE_UPDATE Used to enable or disable the reliable update feature.
- BL_FEATURE_HARDWARE_SWAP_UPDATE Used to switch to the hardware or software implementation of reliable update.
- BL_BACKUP_APP_START Used to define the start address of the backup application if the reliable update feature is enabled.

11.4 Get property

A property has been added to get the state of reliable update. To implement this, a property member called *reliableUpdateStatus* has been added to propertyStore. Additionally, eight new status codes have been defined for the reliable update status. See the following table for details.

Table 11-2. Reliable update status error codes

Status	Value	Description	
kStatus_ReliableUpdateSuccess	10600	Reliable update operation succeeded.	
kStatus_ReliableUpdateFail	10601	Reliable update operation failed.	
kStatus_ReliableUpdateInactive	10602	Reliable update feature is inactive.	
kStatus_ReliableUpdateBackupApplicationInvalid	10603	Backup application is invalid.	
kStatus_ReliableUpdateStillInMainApplic ation	10604	(For hardware implementation only) The bootloader still jumps to the original main application.	
kStatus_ReliableUpdateSwapSystemNot Ready	10605	(For hardware implementation only) Failed to get the swap indicator address from IFR due to the swap system not being ready.	
kStatus_ReliableUpdateBackupBootload erNotReady	10606	(For hardware implementation only) Failed in copying the main application image to the backup application region.	
kStatus_ReliableUpdateSwapIndicatorAddressInvalid	10607	(For hardware implementation only) Swap indicator address is invalid for the swap system.	

Chapter 12 Appendix A: status and error codes

Status and error codes are grouped by component. Each component that defines errors has a group number. This expression is used to construct a status code value.

 $status_code = (group * 100) + code$

Component group numbers are listed in this table.

Table 12-1. Component group numbers

Group	Component	
0	Generic errors	
1	Flash driver	
4	QuadSPI driver	
5	OTFAD driver	
100	Bootloader	
101	SB loader	
102	Memory interface	
103	Property store	
104	CRC checker	
105	Packetizer	
106	Reliable update	

The following table lists all of the error and status codes.

Table 12-2. Status and error codes

Name	Value	Description
kStatus_Success	0	Operation succeeded without error.
kStatus_Fail	1	Operation failed with a generic error.
kStatus_ReadOnly	2	Property cannot be changed because it is read-only.
kStatus_OutOfRange	3	Requested value is out of range.
kStatus_InvalidArgument	4	The requested command's argument is undefined.
kStatus_Timeout	5	A timeout occurred.

Table continues on the next page...

Table 12-2. Status and error codes (continued)

Name	Value	Description
kStatus_NoTransferInProgress	6	The current transfer status is idle.
kStatus_FlashSizeError	100	Not used.
kStatus_FlashAlignmentError	101	Address or length does not meet required alignment.
kStatus_FlashAddressError	102	Address or length is outside addressable memory.
kStatus_FlashAccessError	103	The FTFA_FSTAT[ACCERR] bit is set.
kStatus_FlashProtectionViolation	104	The FTFA_FSTAT[FPVIOL] bit is set.
kStatus_FlashCommandFailure	105	The FTFA_FSTAT[MGSTAT0] bit is set.
kStatus_FlashUnknownProperty	106	Unknown Flash property.
kStatus_FlashEraseKeyError	107	Error in erasing the key.
kStatus_FlashRegionOnExecuteOnly	108	The region is execute only region.
kStatus_FlashAPINotSupported	115	Unsupported Flash API is called.
kStatus_QspiFlashSizeError	400	Error in QuadSPI flash size.
kStatus_QspiFlashAlignmentError	401	Error in QuadSPI flash alignment.
kStatus_QspiFlashAddressError	402	Error in QuadSPI flash address.
kStatus_QspiFlashCommandFailure	403	QuadSPI flash command failure.
kStatus_QspiFlashUnknownProperty	404	Unknown QuadSPI flash property.
kStatus_QspiNotConfigured	405	QuadSPI not configured.
kStatus_QspiCommandNotSupported	406	QuadSPI command not supported.
kStatus_QspiCommandTimeout	407	QuadSPI command timed out.
kStatus_QspiWriteFailure	408	QuadSPI write failure.
kStatusQspiModuleBusy	409	QuadSPI module is busy.
kStatus_OtfadSecurityViolation	500	Security violation in OTFAD module.
kStatus_OtfadLogicallyDisabled	501	OTFAD module is logically disabled.
kStatus_OtfadInvalidKey	502	The key is invalid.
kStatus_OtfadInvalidKeyBlob	503	The key blob is invalid.
kStatus_UnknownCommand	10000	The requested command value is undefined.
kStatus_SecurityViolation	10001	Command is disallowed because flash security is enabled.
kStatus_AbortDataPhase	10002	Abort the data phase early.
kStatus_Ping	10003	Internal: Received ping during command phase.
kStatus_NoResponse	10004	There is no response for the command.
kStatus_NoResponseExpected	10005	There is no response expected for the command.
kStatusRomLdrSectionOverrun	10100	ROM SB loader section overrun.
kStatusRomLdrSignature	10101	ROM SB loader incorrect signature.
kStatusRomLdrSectionLength	10102	ROM SB loader incorrect section length.
kStatusRomLdrUnencryptedOnly	10103	ROM SB loader does not support plain text image.
kStatusRomLdrEOFReached	10104	ROM SB loader EOF reached.
kStatusRomLdrChecksum	10105	ROM SB loader checksum error.
kStatusRomLdrCrc32Error	10106	ROM SB loader CRC32 error.
kStatusRomLdrUnknownCommand	10107	ROM SB loader unknown command.

Table continues on the next page...

Table 12-2. Status and error codes (continued)

Name	Value	Description
kStatusRomLdrldNotFound	10108	ROM SB loader ID not found.
kStatusRomLdrDataUnderrun	10109	ROM SB loader data underrun.
kStatusRomLdrJumpReturned	10110	ROM SB loader return from jump command occurred.
kStatusRomLdrCallFailed	10111	ROM SB loader call command failed.
kStatusRomLdrKeyNotFound	10112	ROM SB loader key not found.
kStatusRomLdrSecureOnly	10113	ROM SB loader security state is secured only.
kStatusRomLdrResetReturned	10114	ROM SB loader return from reset occurred.
kStatusMemoryRangeInvalid	10200	Memory range conflicts with a protected region.
kStatusMemoryReadFailed	10201	Failed to read from memory range.
kStatusMemoryWriteFailed	10202	Failed to write to memory range.
kStatus_UnknownProperty	10300	The requested property value is undefined.
kStatus_ReadOnlyProperty	10301	The requested property value cannot be written.
kStatus_InvalidPropertyValue	10302	The specified property value is invalid.
kStatus_AppCrcCheckPassed	10400	CRC check passed.
kStatus_AppCrcCheckFailed	10401	CRC check failed.
kStatus_AppCrcCheckInactive	10402	CRC checker is not enabled.
kStatus_AppCrcCheckInvalid	10403	Invalid CRC checker due to blank part of BCA not present.
kStatus_AppCrcCheckOutOfRange	10404	CRC check is valid but addresses are out of range.
kStatus_NoPingResponse	10500	Packetizer did not receive any response for the ping packet.
kStatus_InvalidPacketType	10501	Packet type is invalid.
kStatus_InvalidCRC	10502	Invalid CRC in the packet.
kStatus_NoCommandResponse	10503	No response received for the command.
kStatus_ReliableUpdateSuccess	10600	Reliable update process completed successfully.
kStatus_ReliableUpdateFail	10601	Reliable update process failed.
kStatus_ReliableUpdateInacive	10602	Reliable update feature is inactive.
kStatus_ReliableUpdateBackupApplicationInvalid	10603	Backup application image is invalid.
kStatus_ReliableUpdateStillInMainApplic ation	10604	Next boot will still be with Main Application image.
kStatus_ReliableUpdateSwapSystemNo tReady	10605	Cannot swap flash by default because swap system is not ready.
kStatus_ReliableUpdateBackupBootload erNotReady	10606	Cannot swap flash because there is no valid backup bootloader image.
kStatus_ReliableUpdateSwapIndicatorAddressInvalid	10607	Cannot swap flash because provided swap indicator is invalid.

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Chapter 13 Appendix B: GetProperty and SetProperty commands

Properties are the defined units of data that can be accessed with the GetProperty or SetProperty commands. Properties may be read-only or read-write. All read-write properties are 32-bit integers, so that they can easily be carried in a command parameter. Not all properties are available on all platforms. If a property is not available, GetProperty and SetProperty return kStatus_UnknownProperty.

The tag values shown in the table below are used with the GetProperty and SetProperty commands to query information about the bootloader.

Table 13-1. Tag values GetProperty and SetProperty

Name	Writable	Tag value	Size	Description
CurrentVersion	no	0x01	4	The current bootloader version.
AvailablePeripherals	no	0x02	4	The set of peripherals supported on this chip.
FlashStartAddress	no	0x03	4	Start address of program flash.
FlashSizeInBytes	no	0x04	4	Program flash size in bytes.
FlashSectorSize	no	0x05	4	The size of one sector of program flash in bytes. This is the minimum erase size.
FlashBlockCount	no	0x06	4	Number of blocks in the flash array.
AvailableCommands	no	0x07	4	The set of commands supported by the bootloader.
CRCCheckStatus	no	0x08	4	The status of the application CRC check.
Reserved	n/a	0x09	n/a	

Table continues on the next page...

Table 13-1. Tag values GetProperty and SetProperty (continued)

Name	Writable	Tag value	Size	Description
VerifyWrites	yes	0x0a	4	Controls whether the bootloader verifies writes to flash. The VerifyWrites feature is enabled by default.
				0 - No verification is done.
				1 - Enable verification.
MaxPacketSize	no	0x0b	4	Maximum supported packet size for the currently active peripheral interface.
ReservedRegions	no	0x0c	n	List of memory regions reserved by the bootloader. Returned as value pairs (<startaddress-of-region>,<end-address-of-region>). If HasDataPhase flag is not set, then the Response packet parameter count indicates number of pairs. If HasDataPhase flag is set, then the second parameter is the number of bytes in the data phase.</end-address-of-region></startaddress-of-region>
RAMStartAddress	no	0x0e	4	Start address of RAM.
RAMSizeInBytes	no	0x0f	4	RAM size in bytes.
SystemDeviceId	no	0x10	4	Value of the Kinetis System Device Identification register.
FlashSecurityState	no	0x11	4	Indicates whether Flash security is enabled.
				0 - Flash security is disabled.
				1 - Flash security is enabled.
UniqueDeviceId	no	0x12	n	Unique device identification, value of Kinetis Unique Identification registers

Table continues on the next page...

Chapter 13 Appendix B: GetProperty and SetProperty commands

Table 13-1. Tag values GetProperty and SetProperty (continued)

Name	Writable	Tag value	Size	Description
				(16 for K series devices, 12 for KL series devices)
FlashFacSupport	no	0x13	4	FAC (Flash Access Control) support flag
				0 - FAC not supported
				1 - FAC supported
FlashAccessSegmentSi ze	no	0x14	4	The size of 1 segment of flash in bytes.
FlashAccessSegmentC ount	no	0x15	4	FAC segment count (The count of flash access segments within the flash model.)
FlashReadMargin	yes	0x16	4	The margin level setting for flash erase and program verify commands.
				0=Normal
				1=User
				2=Factory
QspilnitStatus	no	0x17	4	The result of the QSPI or OTFAD initialization process.
				405 - QSPI is not initialized
				0 - QSPI is initialized
TargetVersion	no	0x18	4	Target build version number.
ExternalMemoryAttribut es	no	0x19	24	List of attributes supported by the specified memory Id (0=Internal Flash, 1=QuadSpi0). See description for the return value in the section ExternalMemoryAttribut es Property.
ReliableUpdateStatus	-	0x1a	4	Result of last Reliable Update operation. See Table 12-2.

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Chapter 14 Revision history

14.1 Revision History

This table shows the revision history of the document.

Table 14-1. Revision history

Revision number	Date	Substantive changes
0	04/2016	Kinetis Bootloader v2.0.0 release
1	05/2018	MCU Bootloader v2.5.0 release
2	09/2018	MCU Bootloader v2.6.0 release
3	11/2018	MCU Bootloader v2.7.0 release

Revision History

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